



Includes  
MAX 9000A

# MAX 9000

## Programmable Logic Device Family

December 2002, ver. 6.4

Data Sheet

## Features...

- High-performance CMOS EEPROM-based programmable logic devices (PLDs) built on third-generation Multiple Array MatriX (MAX<sup>®</sup>) architecture
- 5.0-V in-system programmability (ISP) through built-in IEEE Std. 1149.1 Joint Test Action Group (JTAG) interface
- Built-in JTAG boundary-scan test (BST) circuitry compliant with IEEE Std. 1149.1-1990
- High-density erasable programmable logic device (EPLD) family ranging from 6,000 to 12,000 usable gates (see [Table 1](#))
- 10-ns pin-to-pin logic delays with counter frequencies of up to 144 MHz
- Fully compliant with the peripheral component interconnect Special Interest Group's (PCI SIG) **PCI Local Bus Specification, Revision 2.2**
- Dual-output macrocell for independent use of combinatorial and registered logic
- FastTrack<sup>®</sup> Interconnect for fast, predictable interconnect delays
- Input/output registers with clear and clock enable on all I/O pins
- Programmable output slew-rate control to reduce switching noise
- MultiVolt<sup>™</sup> I/O interface operation, allowing devices to interface with 3.3-V and 5.0-V devices
- Configurable expander product-term distribution allowing up to 32 product terms per macrocell
- Programmable power-saving mode for more than 50% power reduction in each macrocell

**Table 1. MAX 9000 Device Features**

| Feature                   | EPM9320<br>EPM9320A | EPM9400 | EPM9480 | EPM9560<br>EPM9560A |
|---------------------------|---------------------|---------|---------|---------------------|
| Usable gates              | 6,000               | 8,000   | 10,000  | 12,000              |
| Flipflops                 | 484                 | 580     | 676     | 772                 |
| Macrocells                | 320                 | 400     | 480     | 560                 |
| Logic array blocks (LABs) | 20                  | 25      | 30      | 35                  |
| Maximum user I/O pins     | 168                 | 159     | 175     | 216                 |
| t <sub>PD1</sub> (ns)     | 10                  | 15      | 10      | 10                  |
| t <sub>FSU</sub> (ns)     | 3.0                 | 5       | 3.0     | 3.0                 |
| t <sub>FCO</sub> (ns)     | 4.5                 | 7       | 4.8     | 4.8                 |
| f <sub>CNT</sub> (MHz)    | 144                 | 118     | 144     | 144                 |

## ...and More Features

- Programmable macrocell flipflops with individual clear, preset, clock, and clock enable controls
- Programmable security bit for protection of proprietary designs
- Software design support and automatic place-and-route provided by Altera's MAX+PLUS® II development system on Windows-based PCs as well as Sun SPARCstation, HP 9000 Series 700/800, and IBM RISC System / 6000 workstations
- Additional design entry and simulation support provided by EDIF 2 0 0 and 3 0 0 netlist files, library of parameterized modules (LPM), Verilog HDL, VHDL, and other interfaces to popular EDA tools from manufacturers such as Cadence, Exemplar Logic, Mentor Graphics, OrCAD, Synopsys, Synplicity, and VeriBest
- Programming support with Altera's Master Programming Unit (MPU), BitBlaster™ serial download cable, ByteBlaster™ parallel port download cable, and ByteBlasterMV™ parallel port download cable, as well as programming hardware from third-party manufacturers
- Offered in a variety of package options with 84 to 356 pins (see [Table 2](#))

**Table 2. MAX 9000 Package Options & I/O Counts** *Note (1)*

| Device   | 84-Pin<br>PLCC | 208-Pin<br>RQFP | 240-Pin<br>RQFP | 280-Pin<br>PGA | 304-Pin<br>RQFP | 356-Pin<br>BGA |
|----------|----------------|-----------------|-----------------|----------------|-----------------|----------------|
| EPM9320  | 60 (2)         | 132             | —               | 168            | —               | 168            |
| EPM9320A | 60 (2)         | 132             | —               | —              | —               | 168            |
| EPM9400  | 59 (2)         | 139             | 159             | —              | —               | —              |
| EPM9480  | —              | 146             | 175             | —              | —               | —              |
| EPM9560  | —              | 153             | 191             | 216            | 216             | 216            |
| EPM9560A | —              | 153             | 191             | —              | —               | 216            |

**Notes:**

- (1) MAX 9000 device package types include plastic J-lead chip carrier (PLCC), power quad flat pack (RQFP), ceramic pin-grid array (PGA), and ball-grid array (BGA) packages.
- (2) Perform a complete thermal analysis before committing a design to this device package. See [Application Note 74 \(Evaluating Power for Altera Devices\)](#).

## General Description

The MAX 9000 family of in-system-programmable, high-density, high-performance EPLDs is based on Altera's third-generation MAX architecture. Fabricated on an advanced CMOS technology, the EEPROM-based MAX 9000 family provides 6,000 to 12,000 usable gates, pin-to-pin delays as fast as 10 ns, and counter speeds of up to 144 MHz. The -10 speed grade of the MAX 9000 family is compliant with the **PCI Local Bus Specification, Revision 2.2**. Table 3 shows the speed grades available for MAX 9000 devices.

**Table 3. MAX 9000 Speed Grade Availability**

| Device   | Speed Grade |     |     |
|----------|-------------|-----|-----|
|          | -10         | -15 | -20 |
| EPM9320  |             | ✓   | ✓   |
| EPM9320A | ✓           |     |     |
| EPM9400  |             | ✓   | ✓   |
| EPM9480  |             | ✓   | ✓   |
| EPM9560  |             | ✓   | ✓   |
| EPM9560A | ✓           |     |     |

Table 4 shows the performance of MAX 9000 devices for typical functions.

**Table 4. MAX 9000 Performance** Note (1)

| Application              | Macrocells Used | Speed Grade |           |         | Units |
|--------------------------|-----------------|-------------|-----------|---------|-------|
|                          |                 | -10         | -15       | -20     |       |
| 16-bit loadable counter  | 16              | 144         | 118       | 100     | MHz   |
| 16-bit up/down counter   | 16              | 144         | 118       | 100     | MHz   |
| 16-bit prescaled counter | 16              | 144         | 118       | 100     | MHz   |
| 16-bit address decode    | 1               | 5.6 (10)    | 7.9 (15)  | 10 (20) | ns    |
| 16-to-1 multiplexer      | 1               | 7.7 (12.1)  | 10.9 (18) | 16 (26) | ns    |

**Note:**

- (1) Internal logic array block (LAB) performance is shown. Numbers in parentheses show external delays from row input pin to row I/O pin.

The MAX 9000 architecture supports high-density integration of system-level logic functions. It easily integrates multiple programmable logic devices ranging from PALs, GALs, and 22V10s to field-programmable gate array (FPGA) devices and EPLDs.

All MAX 9000 device packages provide four dedicated inputs for global control signals with large fan-outs. Each I/O pin has an associated I/O cell register with a clock enable control on the periphery of the device. As outputs, these registers provide fast clock-to-output times; as inputs, they offer quick setup times.

MAX 9000 EPLDs provide 5.0-V in-system programmability (ISP). This feature allows the devices to be programmed and reprogrammed on the printed circuit board (PCB) for quick and efficient iterations during design development and debug cycles. MAX 9000 devices are guaranteed for 100 program and erase cycles.

MAX 9000 EPLDs contain 320 to 560 macrocells that are combined into groups of 16 macrocells, called logic array blocks (LABs). Each macrocell has a programmable-AND / fixed-OR array and a configurable register with independently programmable clock, clock enable, clear, and preset functions. For increased flexibility, each macrocell offers a dual-output structure that allows the register and the product terms to be used independently. This feature allows register-rich and combinatorial-intensive designs to be implemented efficiently. The dual-output structure of the MAX 9000 macrocell also improves logic utilization, thus increasing the effective capacity of the devices. To build complex logic functions, each macrocell can be supplemented with both shareable expander product terms and high-speed parallel expander product terms to provide up to 32 product terms per macrocell.

The MAX 9000 family provides programmable speed / power optimization. Speed-critical portions of a design can run at high speed / full power, while the remaining portions run at reduced speed / low power. This speed / power optimization feature enables the user to configure one or more macrocells to operate at 50% or less power while adding only a nominal timing delay. MAX 9000 devices also provide an option that reduces the slew rate of the output buffers, minimizing noise transients when non-speed-critical signals are switching. MAX 9000 devices offer the MultiVolt feature, which allows output drivers to be set for either 3.3-V or 5.0-V operation in mixed-voltage systems.

The MAX 9000 family is supported by Altera's MAX+PLUS II development system, a single, integrated software package that offers schematic, text—including VHDL, Verilog HDL, and the Altera Hardware Description Language (AHDL)—and waveform design entry, compilation and logic synthesis, simulation and timing analysis, and device programming. The MAX+PLUS II software provides EDIF 2.0.0 and 3.0.0, LPM, and other interfaces for additional design entry and simulation support from other industry-standard PC- and UNIX-workstation-based EDA tools. The MAX+PLUS II software runs on Windows-based PCs as well as Sun SPARCstation, HP 9000 Series 700/800, and IBM RISC System / 6000 workstations.



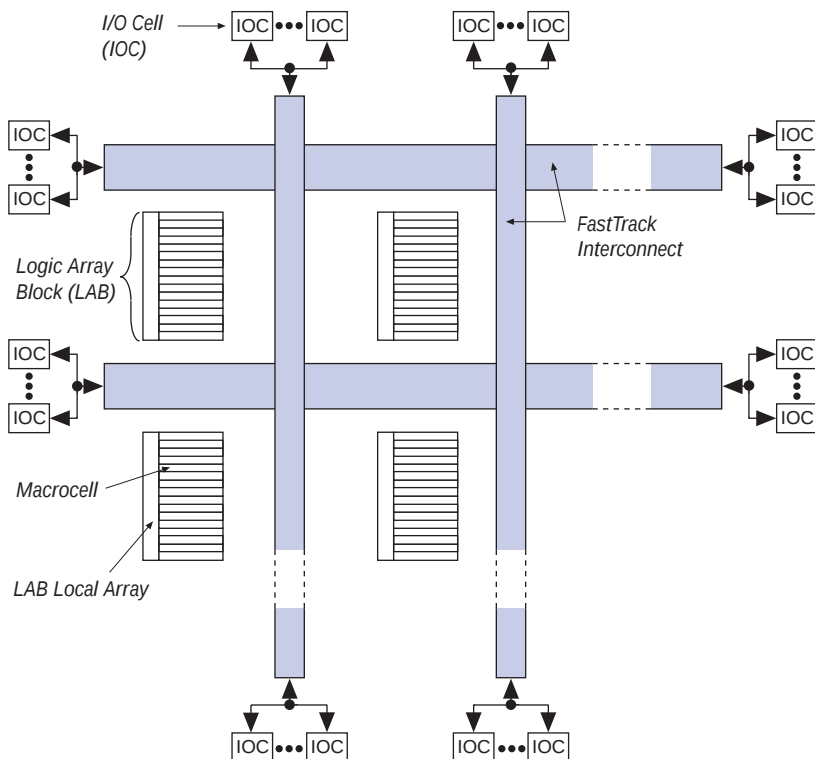
## Functional Description

For more information on development tools, see the *MAX+PLUS II Programmable Logic Development System & Software Data Sheet*.

MAX 9000 devices use a third-generation MAX architecture that yields both high performance and a high degree of utilization for most applications. The MAX 9000 architecture includes the following elements:

- Logic array blocks
- Macrocells
- Expander product terms (shareable and parallel)
- FastTrack Interconnect
- Dedicated inputs
- I/O cells

Figure 1 shows a block diagram of the MAX 9000 architecture.

**Figure 1. MAX 9000 Device Block Diagram**

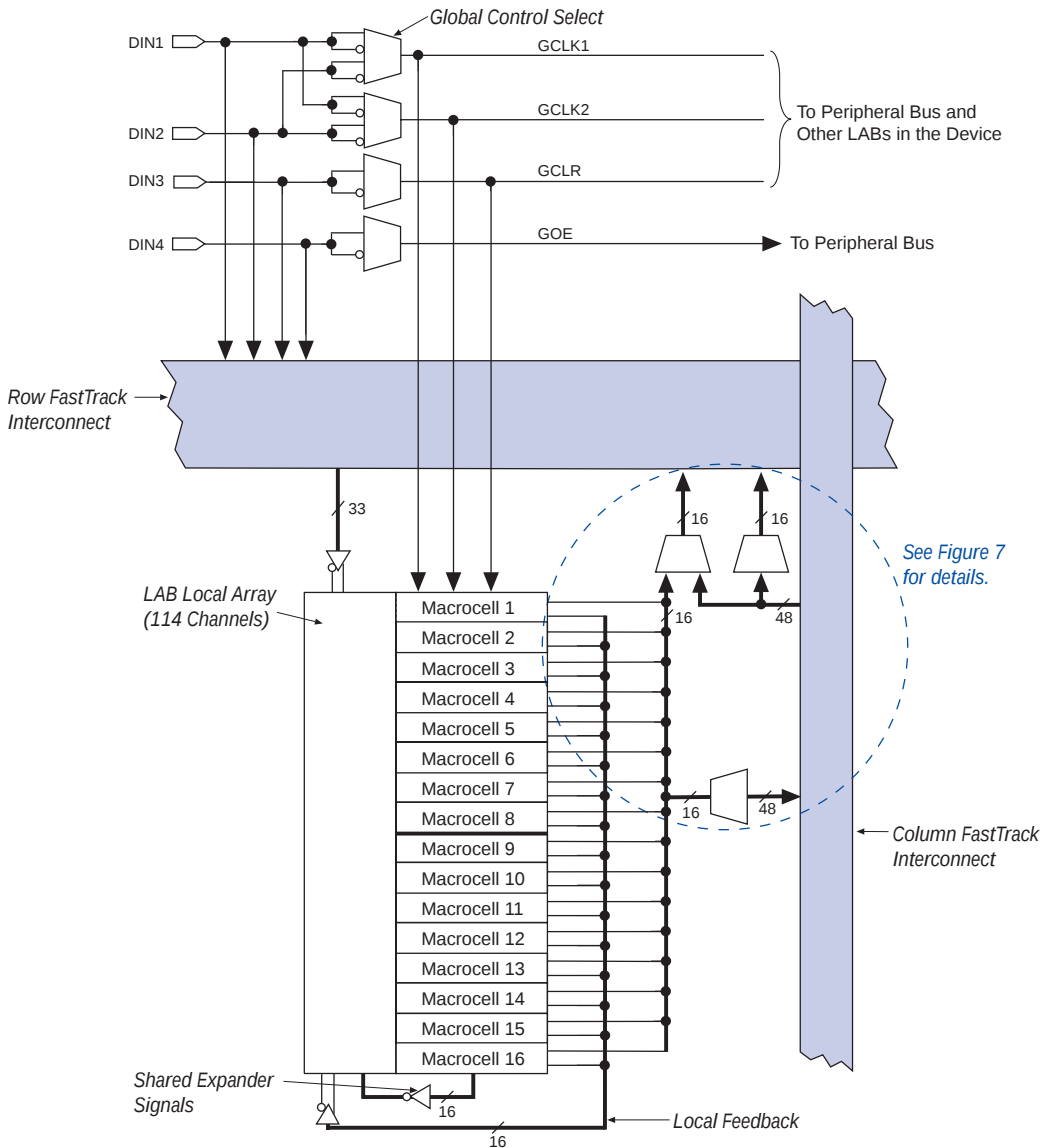
## Logic Array Blocks

The MAX 9000 architecture is based on linking high-performance, flexible logic array modules called logic array blocks (LABs). LABs consist of 16-macrocell arrays that are fed by the LAB local array, as shown in [Figure 2 on page 7](#). Multiple LABs are linked together via the FastTrack Interconnect, a series of fast, continuous channels that run the entire length and width of the device. The I/O pins are supported by I/O cells (IOCs) located at the end of each row (horizontal) and column (vertical) path of the FastTrack Interconnect.

Each LAB is fed by 33 inputs from the row interconnect and 16 feedback signals from the macrocells within the LAB. All of these signals are available within the LAB in their true and inverted form. In addition, 16 shared expander product terms (“expanders”) are available in their inverted form, for a total of 114 signals that feed each product term in the LAB. Each LAB is also fed by two low-skew global clocks and one global clear that can be used for register control signals in all 16 macrocells.

LABs drive the row and column interconnect directly. Each macrocell can drive out of the LAB onto one or both routing resources. Once on the row or column interconnect, signals can traverse to other LABs or to the IOCs.

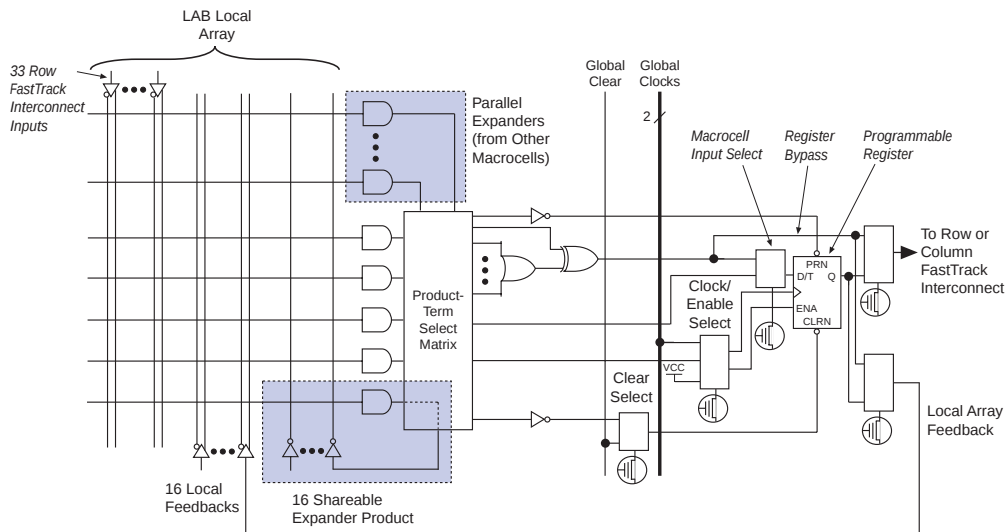
**Figure 2. MAX 9000 Logic Array Block**



## Macrocells

The MAX 9000 macrocell consists of three functional blocks: the product terms, the product-term select matrix, and the programmable register. The macrocell can be individually configured for both sequential and combinatorial logic operation. See [Figure 3](#).

**Figure 3. MAX 9000 Macrocell & Local Array**



Combinatorial logic is implemented in the local array, which provides five product terms per macrocell. The product-term select matrix allocates these product terms for use as either primary logic inputs (to the OR and XOR gates) to implement combinatorial functions, or as secondary inputs to the macrocell's register clear, preset, clock, and clock enable control functions. Two kinds of expander product terms ("expanders") are available to supplement macrocell logic resources:

- Shareable expanders, which are inverted product terms that are fed back into the logic array
- Parallel expanders, which are product terms borrowed from adjacent macrocells

The MAX+PLUS II software automatically optimizes product-term allocation according to the logic requirements of the design.

For registered functions, each macrocell register can be individually programmed for D, T, JK, or SR operation with programmable clock control. The flipflop can also be bypassed for combinatorial operation. During design entry, the user specifies the desired register type; the MAX+PLUS II software then selects the most efficient register operation for each registered function to optimize resource utilization.

Each programmable register can be clocked in three different modes:

- By either global clock signal. This mode achieves the fastest clock-to-output performance.
- By a global clock signal and enabled by an active-high clock enable. This mode provides an enable on each flipflop while still achieving the fast clock-to-output performance of the global clock.
- By an array clock implemented with a product term. In this mode, the flipflop can be clocked by signals from buried macrocells or I/O pins.

Two global clock signals are available. As shown in [Figure 2](#), these global clock signals can be the true or the complement of either of the global clock pins (DIN1 and DIN2).

Each register also supports asynchronous preset and clear functions. As shown in [Figure 3](#), the product-term select matrix allocates product terms to control these operations. Although the product-term-driven preset and clear inputs to registers are active high, active-low control can be obtained by inverting the signal within the logic array. In addition, each register clear function can be individually driven by the dedicated global clear pin (DIN3). The global clear can be programmed for active-high or active-low operation.

All MAX 9000 macrocells offer a dual-output structure that provides independent register and combinatorial logic output within the same macrocell. This function is implemented by a process called register packing. When register packing is used, the product-term select matrix allocates one product term to the D input of the register, while the remaining product terms can be used to implement unrelated combinatorial logic. Both the registered and the combinatorial output of the macrocell can feed either the FastTrack Interconnect or the LAB local array.

## Expander Product Terms

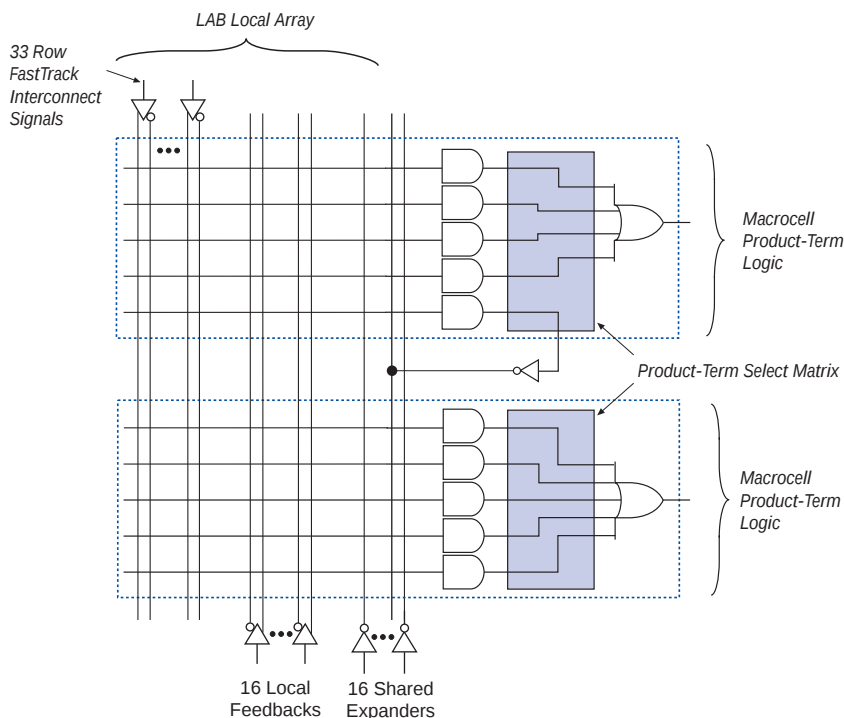
Although most logic functions can be implemented with the five product terms available in each macrocell, some logic functions are more complex and require additional product terms. Although another macrocell can supply the required logic resources, the MAX 9000 architecture also offers both shareable and parallel expander product terms that provide additional product terms directly to any macrocell in the same LAB. These expanders help ensure that logic is synthesized with the fewest possible logic resources to obtain the fastest possible speed.

### Shareable Expanders

Each LAB has 16 shareable expanders that can be viewed as a pool of uncommitted single product terms (one from each macrocell) with inverted outputs that feed back into the LAB local array. Each shareable expander can be used and shared by any or all macrocells in the LAB to build complex logic functions. A small delay ( $t_{LOCAL} + t_{EXP}$ ) is incurred when shareable expanders are used. Figure 4 shows how shareable expanders can feed multiple macrocells.

**Figure 4. MAX 9000 Shareable Expanders**

Shareable expanders can be shared by any or all macrocells in the LAB.

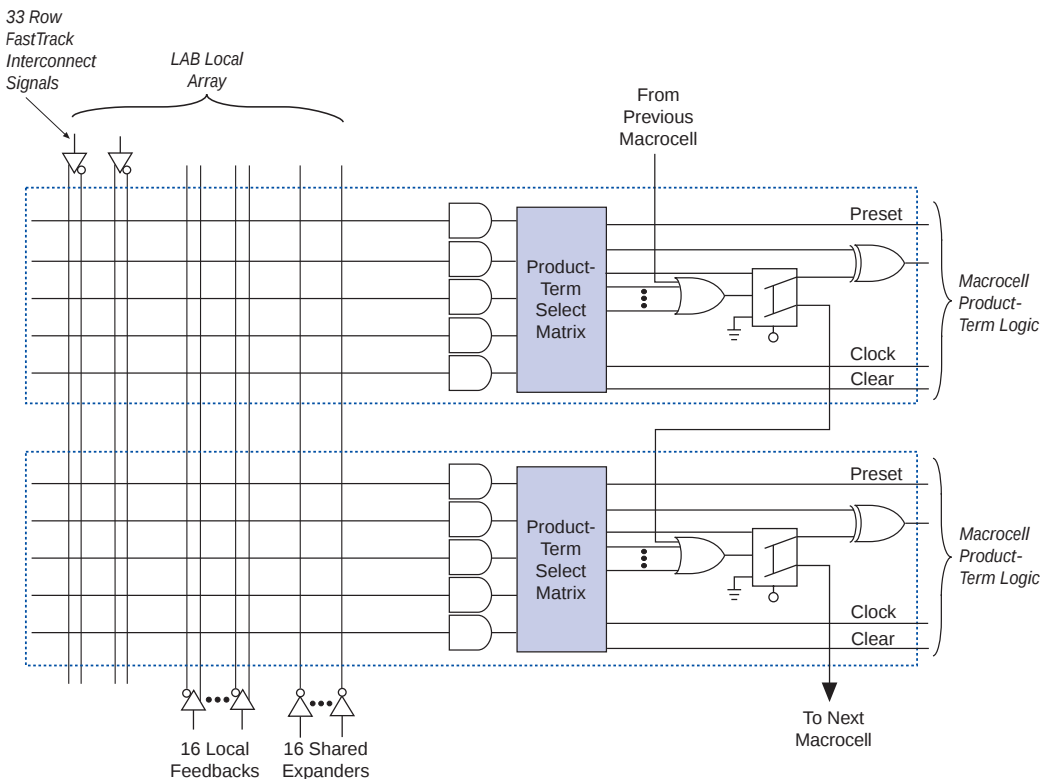


### Parallel Expanders

Parallel expanders are unused product terms that can be allocated to a neighboring macrocell to implement fast, complex logic functions. Parallel expanders allow up to 20 product terms to directly feed the macrocell OR logic, with five product terms provided by the macrocell and 15 parallel expanders provided by neighboring macrocells in the LAB. [Figure 5](#) shows how parallel expanders can feed the neighboring macrocell.

**Figure 5. MAX 9000 Parallel Expanders**

*Unused product terms in a macrocell can be allocated to a neighboring macrocell.*



The MAX+PLUS II Compiler automatically allocates as many as three sets of up to five parallel expanders to macrocells that require additional product terms. Each set of expanders incurs a small, incremental timing delay ( $t_{PEXP}$ ). For example, if a macrocell requires 14 product terms, the Compiler uses the five dedicated product terms within the macrocell and allocates two sets of parallel expanders; the first set includes five product terms and the second set includes four product terms, increasing the total delay by  $2 \times t_{PEXP}$ .

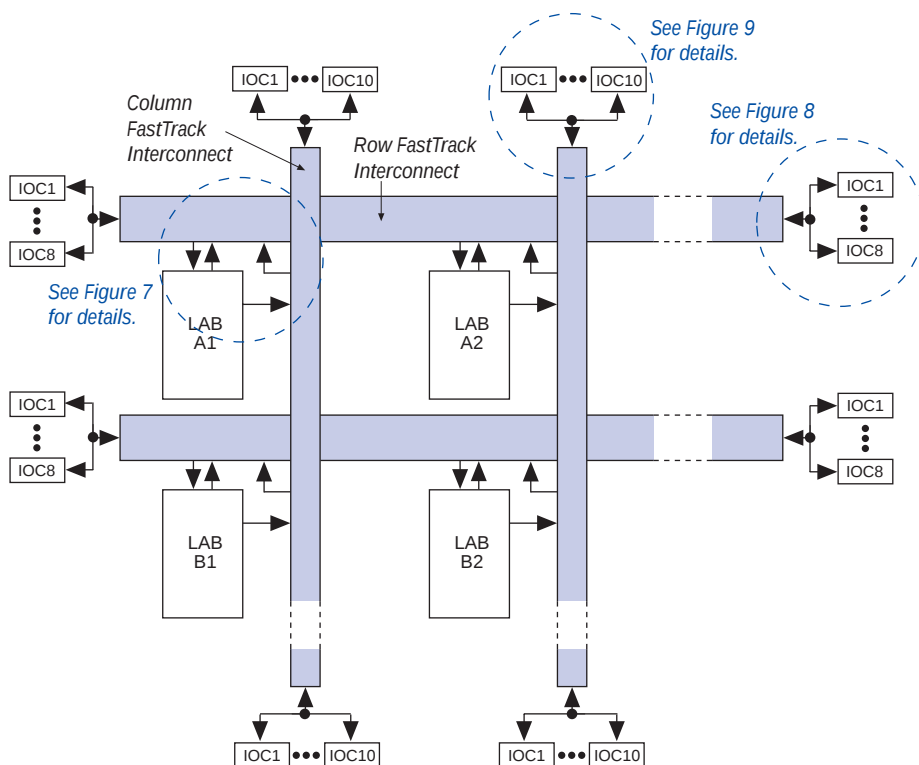
Two groups of eight macrocells within each LAB (e.g., macrocells 1 through 8 and 9 through 16) form two chains to lend or borrow parallel expanders. A macrocell borrows parallel expanders from lower-numbered macrocells. For example, macrocell 8 can borrow parallel expanders from macrocell 7, from macrocells 7 and 6, or from macrocells 7, 6, and 5. Within each group of 8, the lowest-numbered macrocell can only lend parallel expanders and the highest-numbered macrocell can only borrow them.

### FastTrack Interconnect

In the MAX 9000 architecture, connections between macrocells and device I/O pins are provided by the FastTrack Interconnect, a series of continuous horizontal and vertical routing channels that traverse the entire device. This device-wide routing structure provides predictable performance even in complex designs. In contrast, the segmented routing in FPGAs requires switch matrices to connect a variable number of routing paths, increasing the delays between logic resources and reducing performance. [Figure 6](#) shows the interconnection of four adjacent LABs with row and column interconnects.

**Figure 6. MAX 9000 Device Interconnect Resources**

Each LAB is named on the basis of its physical row (A, B, C, etc.) and column (1, 2, 3, etc.) position within the device.



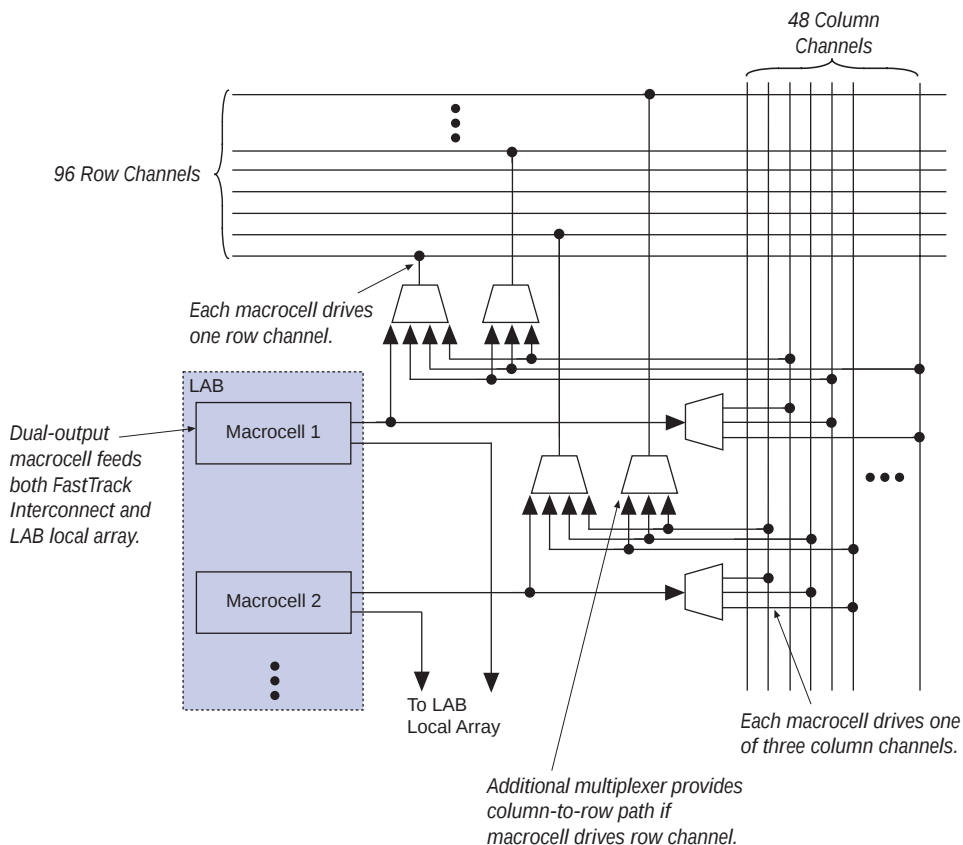
The LABs within MAX 9000 devices are arranged into a matrix of columns and rows. Table 5 shows the number of columns and rows in each MAX 9000 device.

**Table 5. MAX 9000 Rows & Columns**

| Devices           | Rows | Columns |
|-------------------|------|---------|
| EPM9320, EPM9320A | 4    | 5       |
| EPM9400           | 5    | 5       |
| EPM9480           | 6    | 5       |
| EPM9560, EPM9560A | 7    | 5       |

Each row of LABs has a dedicated row interconnect that routes signals both into and out of the LABs in the row. The row interconnect can then drive I/O pins or feed other LABs in the device. Each row interconnect has a total of 96 channels. Figure 7 shows how a macrocell drives the row and column interconnect.

**Figure 7. MAX 9000 LAB Connections to Row & Column Interconnect**



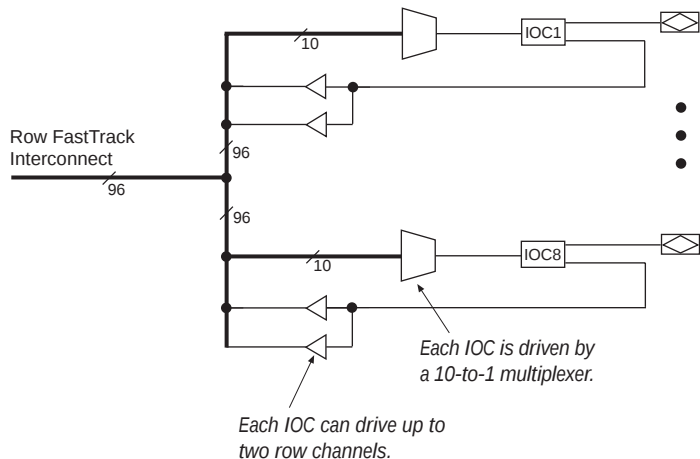
Each macrocell in the LAB can drive one of three separate column interconnect channels. The column channels run vertically across the entire device, and are shared by the macrocells in the same column. The MAX+PLUS II Compiler optimizes connections to a column channel automatically.

A row interconnect channel can be fed by the output of the macrocell through a 4-to-1 multiplexer that the macrocell shares with three column channels. If the multiplexer is used for a macrocell-to-row connection, the three column signals can access another row channel via an additional 3-to-1 multiplexer. Within any LAB, the multiplexers provide all 48 column channels with access to 32 row channels.

### Row-to-I/O Cell Connections

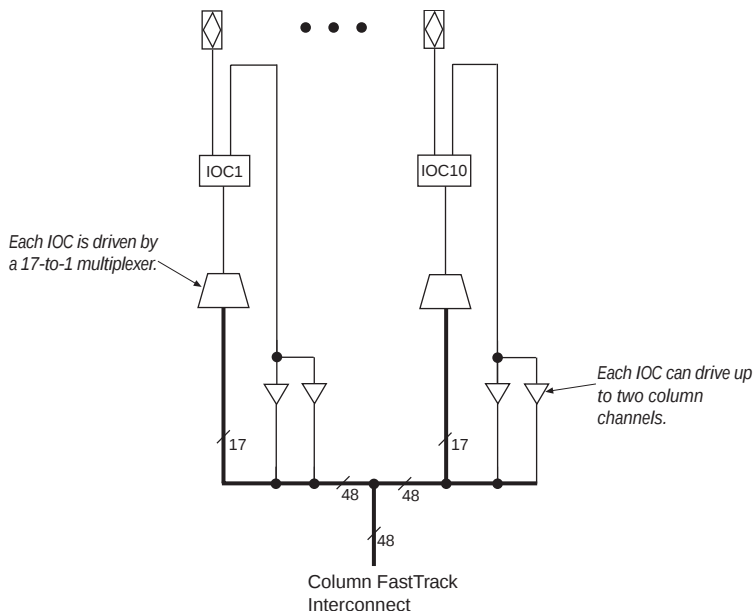
Figure 8 illustrates the connections between row interconnect channels and IOCs. An input signal from an IOC can drive two separate row channels. When an IOC is used as an output, the signal is driven by a 10-to-1 multiplexer that selects the row channels. Each end of the row channel feeds up to eight IOCs on the periphery of the device.

**Figure 8. MAX 9000 Row-to-IOC Connections**



### Column-to-I/O Cell Connections

Each end of a column channel has up to 10 IOCs (see Figure 9). An input signal from an IOC can drive two separate column channels. When an IOC is used as an output, the signal is driven by a 17-to-1 multiplexer that selects the column channels.

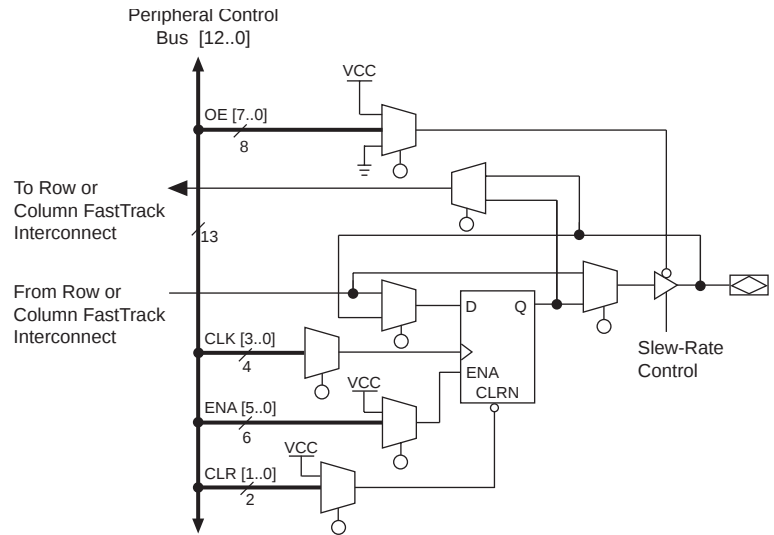
**Figure 9. MAX 9000 Column-to-I/O Connections**

## Dedicated Inputs

In addition to the general-purpose I/O pins, MAX 9000 devices have four dedicated input pins. These dedicated inputs provide low-skew, device-wide signal distribution to the LABs and IOCs in the device, and are typically used for global clock, clear, and output enable control signals. The global control signals can feed the macrocell or IOC clock and clear inputs, as well as the IOC output enable. The dedicated inputs can also be used as general-purpose data inputs because they can feed the row FastTrack Interconnect (see [Figure 2 on page 7](#)).

## I/O Cells

[Figure 10](#) shows the IOC block diagram. Signals enter the MAX 9000 device from either the I/O pins that provide general-purpose input capability or from the four dedicated inputs. The IOCs are located at the ends of the row and column interconnect channels.

**Figure 10. MAX 9000 IOC**

I/O pins can be used as input, output, or bidirectional pins. Each IOC has an IOC register with a clock enable input. This register can be used either as an input register for external data that requires fast setup times, or as an output register for data that requires fast clock-to-output performance. The IOC register clock enable allows the global clock to be used for fast clock-to-output performance, while maintaining the flexibility required for selective clocking.

The clock, clock enable, clear, and output enable controls for the IOCs are provided by a network of I/O control signals. These signals can be supplied by either the dedicated input pins or internal logic. The IOC control-signal paths are designed to minimize the skew across the device. All control-signal sources are buffered onto high-speed drivers that drive the signals around the periphery of the device. This “peripheral bus” can be configured to provide up to eight output enable signals, up to four clock signals, up to six clock enable signals, and up to two clear signals. [Table 6 on page 18](#) shows the sources that drive the peripheral bus and how the IOC control signals share the peripheral bus.

The output buffer in each IOC has an adjustable output slew rate that can be configured for low-noise or high-speed performance. A slower slew rate reduces board-level noise and adds a nominal timing delay to the output buffer delay ( $t_{OD}$ ) parameter. The fast slew rate should be used for speed-critical outputs in systems that are adequately protected against noise. Designers can specify the slew rate on a pin-by-pin basis during design entry or assign a default slew rate to all pins on a global basis. The slew rate control affects both rising and falling edges of the output signals.

**Table 6. Peripheral Bus Sources**

| Peripheral Control Signal | Source              |            |            |                     |
|---------------------------|---------------------|------------|------------|---------------------|
|                           | EPM9320<br>EPM9320A | EPM9400    | EPM9480    | EPM9560<br>EPM9560A |
| OE0/ENA0                  | Row C               | Row E      | Row F      | Row G               |
| OE1/ENA1                  | Row B               | Row E      | Row F      | Row F               |
| OE2/ENA2                  | Row A               | Row E      | Row E      | Row E               |
| OE3/ENA3                  | Row B               | Row B      | Row B      | Row B               |
| OE4/ENA4                  | Row A               | Row A      | Row A      | Row A               |
| OE5                       | Row D               | Row D      | Row D      | Row D               |
| OE6                       | Row C               | Row C      | Row C      | Row C               |
| OE7/CLR1                  | Row B/G0E           | Row B/G0E  | Row B/G0E  | Row B/G0E           |
| CLR0/ENA5                 | Row A/GCLR          | Row A/GCLR | Row A/GCLR | Row A/GCLR          |
| CLK0                      | GCLK1               | GCLK1      | GCLK1      | GCLK1               |
| CLK1                      | GCLK2               | GCLK2      | GCLK2      | GCLK2               |
| CLK2                      | Row D               | Row D      | Row D      | Row D               |
| CLK3                      | Row C               | Row C      | Row C      | Row C               |

## Output Configuration

The MAX 9000 device architecture supports the MultiVolt I/O interface feature, which allows MAX 9000 devices to interface with systems of differing supply voltages. The 5.0-V devices in all packages can be set for 3.3-V or 5.0-V I/O pin operation. These devices have one set of  $V_{CC}$  pins for internal operation and input buffers ( $V_{CCINT}$ ), and another set for I/O output drivers ( $V_{CCIO}$ ).

The  $V_{CCINT}$  pins must always be connected to a 5.0-V power supply. With a 5.0-V  $V_{CCINT}$  level, input voltages are at TTL levels and are therefore compatible with 3.3-V and 5.0-V inputs.

The VCCIO pins can be connected to either a 3.3-V or 5.0-V power supply, depending on the output requirements. When the VCCIO pins are connected to a 5.0-V power supply, the output levels are compatible with 5.0-V systems. When the VCCIO pins are connected to a 3.3-V power supply, the output high is at 3.3 V and is therefore compatible with 3.3-V or 5.0-V systems. Devices operating with  $V_{CCIO}$  levels lower than 4.75 V incur a nominally greater timing delay of  $t_{OD2}$  instead of  $t_{OD1}$ .

## In-System Programmability (ISP)

MAX 9000 devices can be programmed in-system through a 4-pin JTAG interface. ISP offers quick and efficient iterations during design development and debug cycles. The MAX 9000 architecture internally generates the 12.0-V programming voltage required to program EEPROM cells, eliminating the need for an external 12.0-V power supply to program the devices on the board. During ISP, the I/O pins are tri-stated to eliminate board conflicts.

ISP simplifies the manufacturing flow by allowing the devices to be mounted on a printed circuit board with standard pick-and-place equipment before they are programmed. MAX 9000 devices can be programmed by downloading the information via in-circuit testers, embedded processors, or the Altera BitBlaster, ByteBlaster, or ByteBlasterMV download cable. (The ByteBlaster cable is obsolete and has been replaced by the ByteBlasterMV cable, which can interface with 2.5-V, 3.3-V, and 5.0-V devices.) Programming the devices after they are placed on the board eliminates lead damage on high pin-count packages (e.g., QFP packages) due to device handling. MAX 9000 devices can also be reprogrammed in the field (i.e., product upgrades can be performed in the field via software or modem).

In-system programming can be accomplished with either an adaptive or constant algorithm. An adaptive algorithm reads information from the unit and adapts subsequent programming steps to achieve the fastest possible programming time for that unit. Because some in-circuit testers platforms have difficulties supporting an adaptive algorithm, Altera offers devices tested with a constant algorithm. Devices tested to the constant algorithm have an “F” suffix in the ordering code.

## Programming with External Hardware

MAX 9000 devices can be programmed on Windows-based PCs with an Altera Logic Programmer card, the Master Programming Unit (MPU), and the appropriate device adapter. The MPU performs continuity checking to ensure adequate electrical contact between the adapter and the device.



For more information, see the [Altera Programming Hardware Data Sheet](#).

The MAX+PLUS II software can use text- or waveform-format test vectors created with the MAX+PLUS II Text Editor or Waveform Editor to test a programmed device. For added design verification, designers can perform functional testing to compare the functional behavior of a MAX 9000 device with the results of simulation.

Data I/O, BP Microsystems, and other programming hardware manufacturers also provide programming support for Altera devices.



For more information, see [Programming Hardware Manufacturers](#).

**IEEE Std.  
1149.1 (JTAG)  
Boundary-Scan  
Support**

MAX 9000 devices support JTAG BST circuitry as specified by IEEE Std. 1149.1-1990. [Table 7](#) describes the JTAG instructions supported by the MAX 9000 family. The pin-out tables starting on [page 35](#) show the location of the JTAG control pins for each device. If the JTAG interface is not required, the JTAG pins are available as user I/O pins.

| Table 7. MAX 9000 JTAG Instructions |                                                                                                                                                                                                                                                                               |
|-------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| JTAG Instruction                    | Description                                                                                                                                                                                                                                                                   |
| SAMPLE/PRELOAD                      | Allows a snapshot of signals at the device pins to be captured and examined during normal device operation, and permits an initial data pattern output at the device pins.                                                                                                    |
| EXTEST                              | Allows the external circuitry and board-level interconnections to be tested by forcing a test pattern at the output pins and capturing test results at the input pins.                                                                                                        |
| BYPASS                              | Places the 1-bit bypass register between the TDI and TD0 pins, which allows the BST data to pass synchronously through a selected device to adjacent devices during normal device operation.                                                                                  |
| IDCODE                              | Selects the IDCODE register and places it between TDI and TD0, allowing the IDCODE to be shifted out of TD0. Supported by the EPM9320A, EPM9400, EPM9480, and EPM9560A devices only.                                                                                          |
| UESCODE                             | Selects the user electronic signature (UESCODE) register and allows the UESCODE to be shifted out of TD0 serially. This instruction is supported by MAX 9000A devices only.                                                                                                   |
| ISP Instructions                    | These instructions are used when programming MAX 9000 devices via the JTAG ports with the BitBlaster or ByteBlasterMV download cable, or using a Jam File (.jam), Jam Byte-Code File (.jbc), or Serial Vector Format (.svf) File via an embedded processor or test equipment. |

The instruction register length for MAX 9000 devices is 10 bits. EPM9320A and EPM9560A devices support a 16-bit UESCODE register. [Tables 8 and 9](#) show the boundary-scan register length and device IDCODE information for MAX 9000 devices.

**Table 8. MAX 9000 Boundary-Scan Register Length**

| Device            | Boundary-Scan Register Length |
|-------------------|-------------------------------|
| EPM9320, EPM9320A | 504                           |
| EPM9400           | 552                           |
| EPM9480           | 600                           |
| EPM9560, EPM9560A | 648                           |

**Table 9. 32-Bit MAX 9000 Device IDCODE** *Note (1)*

| Device       | IDCODE (32 Bits) |                           |                                   |           |
|--------------|------------------|---------------------------|-----------------------------------|-----------|
|              | Version (4 Bits) | Part Number (16 Bits) (2) | Manufacturer's Identity (11 Bits) | 1 (1 Bit) |
| EPM9320A (3) | 0000             | 1001 0011 0010 0000       | 000011011110                      | 1         |
| EPM9400      | 0000             | 1001 0100 0000 0000       | 000011011110                      | 1         |
| EPM9480      | 0000             | 1001 0100 1000 0000       | 000011011110                      | 1         |
| EPM9560A (3) | 0000             | 1001 0101 0110 0000       | 000011011110                      | 1         |

**Notes:**

- (1) The IDCODE's least significant bit (LSB) is always 1.
- (2) The most significant bit (MSB) is on the left.
- (3) Although the EPM9320A and EPM9560A devices support the IDCODE instruction, the EPM9320 and EPM9560 devices do not.

[Figure 11](#) shows the timing requirements for the JTAG signals.

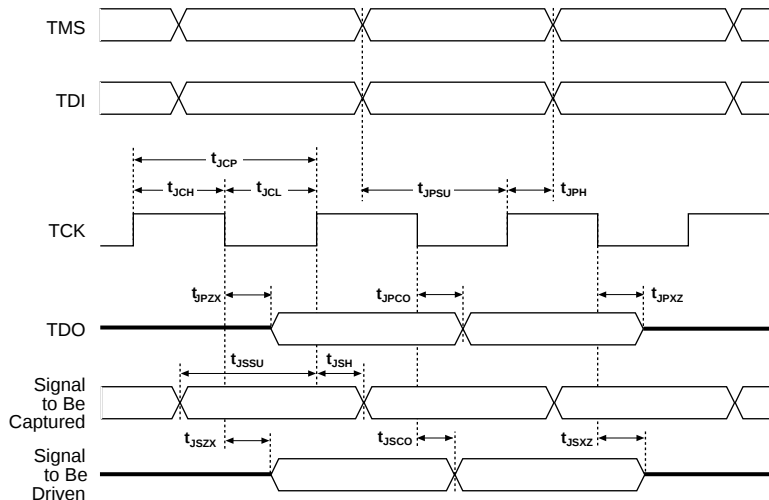
**Figure 11. MAX 9000 JTAG Waveforms**

Table 10 shows the JTAG timing parameters and values for MAX 9000 devices.

**Table 10. JTAG Timing Parameters & Values for MAX 9000 Devices**

| Symbol     | Parameter                                      | Min | Max | Unit |
|------------|------------------------------------------------|-----|-----|------|
| $t_{JCP}$  | TCK clock period                               | 100 |     | ns   |
| $t_{JCH}$  | TCK clock high time                            | 50  |     | ns   |
| $t_{JCL}$  | TCK clock low time                             | 50  |     | ns   |
| $t_{JPSU}$ | JTAG port setup time                           | 20  |     | ns   |
| $t_{JPH}$  | JTAG port hold time                            | 45  |     | ns   |
| $t_{JPCO}$ | JTAG port clock to output                      |     | 25  | ns   |
| $t_{JPZX}$ | JTAG port high impedance to valid output       |     | 25  | ns   |
| $t_{JPXZ}$ | JTAG port valid output to high impedance       |     | 25  | ns   |
| $t_{JSSU}$ | Capture register setup time                    | 20  |     | ns   |
| $t_{JSH}$  | Capture register hold time                     | 45  |     | ns   |
| $t_{JSCO}$ | Update register clock to output                |     | 25  | ns   |
| $t_{JSZX}$ | Update register high impedance to valid output |     | 25  | ns   |
| $t_{JSXZ}$ | Update register valid output to high impedance |     | 25  | ns   |



For detailed information on JTAG operation in MAX 9000 devices, refer to *Application Note 39 (IEEE 1149.1 (JTAG) Boundary-Scan Testing in Altera Devices)*.

## Programmable Speed/Power Control

MAX 9000 devices offer a power-saving mode that supports low-power operation across user-defined signal paths or the entire device. Because most logic applications require only a small fraction of all gates to operate at maximum frequency, this feature allows total power dissipation to be reduced by 50% or more.

The designer can program each individual macrocell in a MAX 9000 device for either high-speed (i.e., with the Turbo Bit™ option turned on) or low-power (i.e., with the Turbo Bit option turned off) operation. As a result, speed-critical paths in the design can run at high speed, while remaining paths operate at reduced power. Macrocells that run at low power incur a nominal timing delay adder ( $t_{LPA}$ ) for the LAB local array delay ( $t_{LOCAL}$ ).

## Design Security

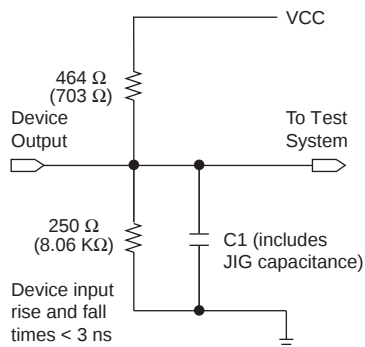
All MAX 9000 EPLDs contain a programmable security bit that controls access to the data programmed into the device. When this bit is programmed, a proprietary design implemented in the device cannot be copied or retrieved. This feature provides a high level of design security, because programmed data within EEPROM cells is invisible. The security bit that controls this function, as well as all other programmed data, is reset only when the device is erased.

## Generic Testing

MAX 9000 EPLDs are fully functionally tested. Complete testing of each programmable EEPROM bit and all logic functionality ensures 100% programming yield. AC test measurements are taken under conditions equivalent to those shown in Figure 12. Test patterns can be used and then erased during the early stages of the production flow.

**Figure 12. MAX 9000 AC Test Conditions**

Power supply transients can affect AC measurements. Simultaneous transitions of multiple outputs should be avoided for accurate measurement. Threshold tests must not be performed under AC conditions. Large-amplitude, fast ground-current transients normally occur as the device outputs discharge the load capacitances. When these transients flow through the parasitic inductance between the device ground pin and the test system ground, significant reductions in observable noise immunity can result. Numbers in parentheses are for 3.3-V outputs. Numbers without parentheses are for 5.0-V devices or outputs.



## Operating Conditions

Tables 11 through 17 provide information on absolute maximum ratings, recommended operating conditions, operating conditions, and capacitance for MAX 9000 devices.

**Table 11. MAX 9000 Device Absolute Maximum Ratings** *Note (1)*

| Symbol             | Parameter                                   | Conditions                         | Min  | Max | Unit |
|--------------------|---------------------------------------------|------------------------------------|------|-----|------|
| V <sub>CC</sub>    | Supply voltage                              | With respect to ground (2)         | –2.0 | 7.0 | V    |
| V <sub>I</sub>     | DC input voltage                            |                                    | –2.0 | 7.0 | V    |
| V <sub>CCISP</sub> | Supply voltage during in-system programming |                                    | –2.0 | 7.0 | V    |
| I <sub>OUT</sub>   | DC output current, per pin                  |                                    | –25  | 25  | mA   |
| T <sub>STG</sub>   | Storage temperature                         | No bias                            | –65  | 150 | °C   |
| T <sub>AMB</sub>   | Ambient temperature                         | Under bias                         | –65  | 135 | °C   |
| T <sub>J</sub>     | Junction temperature                        | Ceramic packages, under bias       |      | 150 | °C   |
|                    |                                             | PQFP and RQFP packages, under bias |      | 135 | °C   |

**Table 12. MAX 9000 Device Recommended Operating Conditions**

| Symbol             | Parameter                                           | Conditions         | Min            | Max                      | Unit |
|--------------------|-----------------------------------------------------|--------------------|----------------|--------------------------|------|
| V <sub>CCINT</sub> | Supply voltage for internal logic and input buffers | (3), (4)           | 4.75<br>(4.50) | 5.25<br>(5.50)           | V    |
| V <sub>CCIO</sub>  | Supply voltage for output drivers, 5.0-V operation  | (3), (4)           | 4.75<br>(4.50) | 5.25<br>(5.50)           | V    |
|                    | Supply voltage for output drivers, 3.3-V operation  | (3), (4)           | 3.00<br>(3.00) | 3.60<br>(3.60)           | V    |
| V <sub>CCISP</sub> | Supply voltage during in-system programming         |                    | 4.75           | 5.25                     | V    |
| V <sub>I</sub>     | Input voltage                                       |                    | –0.5           | V <sub>CCINT</sub> + 0.5 | V    |
| V <sub>O</sub>     | Output voltage                                      |                    | 0              | V <sub>CCIO</sub>        | V    |
| T <sub>A</sub>     | Ambient temperature                                 | For commercial use | 0              | 70                       | °C   |
|                    |                                                     | For industrial use | –40            | 85                       | °C   |
| T <sub>J</sub>     | Junction temperature                                | For commercial use | 0              | 90                       | °C   |
|                    |                                                     | For industrial use | –40            | 105                      | °C   |
| t <sub>R</sub>     | Input rise time                                     |                    |                | 40                       | ns   |
| t <sub>F</sub>     | Input fall time                                     |                    |                | 40                       | ns   |

**Table 13. MAX 9000 Device DC Operating Conditions** Notes (5), (6)

| Symbol   | Parameter                                       | Conditions                                     | Min              | Max               | Unit    |
|----------|-------------------------------------------------|------------------------------------------------|------------------|-------------------|---------|
| $V_{IH}$ | High-level input voltage                        | (7)                                            | 2.0              | $V_{CCINT} + 0.5$ | V       |
| $V_{IL}$ | Low-level input voltage                         |                                                | -0.5             | 0.8               | V       |
| $V_{OH}$ | 5.0-V high-level TTL output voltage             | $I_{OH} = -4$ mA DC, $V_{CCIO} = 4.75$ V (8)   | 2.4              |                   | V       |
|          | 3.3-V high-level TTL output voltage             | $I_{OH} = -4$ mA DC, $V_{CCIO} = 3.00$ V (8)   | 2.4              |                   | V       |
|          | 3.3-V high-level CMOS output voltage            | $I_{OH} = -0.1$ mA DC, $V_{CCIO} = 3.00$ V (8) | $V_{CCIO} - 0.2$ |                   | V       |
| $V_{OL}$ | 5.0-V low level TTL output voltage              | $I_{OL} = 12$ mA DC, $V_{CCIO} = 4.75$ V (8)   |                  | 0.45              | V       |
|          | 3.3-V low-level TTL output voltage              | $I_{OL} = 12$ mA DC, $V_{CCIO} = 3.00$ V (8)   |                  | 0.45              | V       |
|          | 3.3-V low-level CMOS output voltage             | $I_{OL} = 0.1$ mA DC, $V_{CCIO} = 3.00$ V (8)  |                  | 0.2               | V       |
| $I_I$    | I/O pin leakage current of dedicated input pins | $V_I = -0.5$ to $5.5$ V (9)                    | -10              | 10                | $\mu$ A |
| $I_{OZ}$ | Tri-state output off-state current              | $V_I = -0.5$ to $5.5$ V                        | -40              | 40                | $\mu$ A |

**Table 14. MAX 9000 Device Capacitance: EPM9320, EPM9400, EPM9480 & EPM9560 Devices** Note (10)

| Symbol     | Parameter                   | Conditions                    | Min | Max | Unit |
|------------|-----------------------------|-------------------------------|-----|-----|------|
| $C_{DIN1}$ | Dedicated input capacitance | $V_{IN} = 0$ V, $f = 1.0$ MHz |     | 18  | pF   |
| $C_{DIN2}$ | Dedicated input capacitance | $V_{IN} = 0$ V, $f = 1.0$ MHz |     | 18  | pF   |
| $C_{DIN3}$ | Dedicated input capacitance | $V_{IN} = 0$ V, $f = 1.0$ MHz |     | 17  | pF   |
| $C_{DIN4}$ | Dedicated input capacitance | $V_{IN} = 0$ V, $f = 1.0$ MHz |     | 20  | pF   |
| $C_{I/O}$  | I/O pin capacitance         | $V_{IN} = 0$ V, $f = 1.0$ MHz |     | 12  | pF   |

**Table 15. MAX 9000A Device Capacitance: EPM9320A & EPM9560A Devices** Note (10)

| Symbol     | Parameter                   | Conditions                    | Min | Max | Unit |
|------------|-----------------------------|-------------------------------|-----|-----|------|
| $C_{DIN1}$ | Dedicated input capacitance | $V_{IN} = 0$ V, $f = 1.0$ MHz |     | 16  | pF   |
| $C_{DIN2}$ | Dedicated input capacitance | $V_{IN} = 0$ V, $f = 1.0$ MHz |     | 10  | pF   |
| $C_{DIN3}$ | Dedicated input capacitance | $V_{IN} = 0$ V, $f = 1.0$ MHz |     | 10  | pF   |
| $C_{DIN4}$ | Dedicated input capacitance | $V_{IN} = 0$ V, $f = 1.0$ MHz |     | 12  | pF   |
| $C_{I/O}$  | I/O pin capacitance         | $V_{IN} = 0$ V, $f = 1.0$ MHz |     | 8   | pF   |

**Table 16. MAX 9000 Device Typical  $I_{CC}$  Supply Current Values**

| Symbol    | Parameter                                                  | Conditions                   | EPM9320 | EPM9400 | EPM9480 | EPM9560 | Unit |
|-----------|------------------------------------------------------------|------------------------------|---------|---------|---------|---------|------|
| $I_{CC1}$ | $I_{CC}$ supply current (low-power mode, standby, typical) | $V_I =$ ground, no load (11) | 106     | 132     | 140     | 146     | mA   |

**Table 17. MAX 9000A Device Typical  $I_{CC}$  Supply Current Values**

| Symbol    | Parameter                                                  | Conditions                   | EPM9320A | EPM9560A | Unit |
|-----------|------------------------------------------------------------|------------------------------|----------|----------|------|
| $I_{CC1}$ | $I_{CC}$ supply current (low-power mode, standby, typical) | $V_I$ = ground, no load (11) | 99       | 174      | mA   |

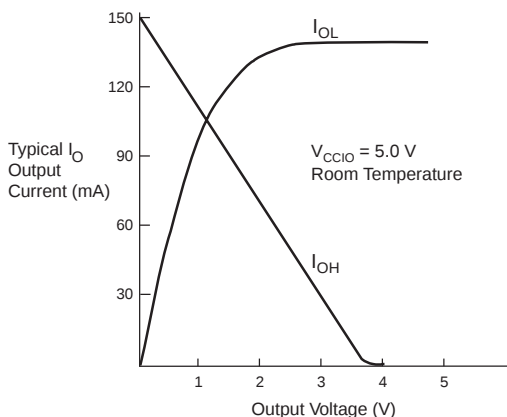
**Notes to tables:**

- (1) See the *Operating Requirements for Altera Devices Data Sheet*.
- (2) Minimum DC input on I/O pins is  $-0.5$  V and on the four dedicated input pins is  $-0.3$  V. During transitions, the inputs may undershoot to  $-2.0$  V or overshoot to  $7.0$  V for periods shorter than 20 ns under no-load conditions.
- (3)  $V_{CC}$  must rise monotonically.
- (4) Numbers in parentheses are for industrial-temperature-range devices.
- (5) Typical values are for  $T_A = 25^\circ\text{C}$  and  $V_{CC} = 5.0$  V.
- (6) These values are specified under the MAX 9000 recommended operating conditions, shown in Table 12 on page 24.
- (7) During in-system programming, the minimum  $V_{IH}$  of the JTAG TCK pin is 3.6 V. The minimum  $V_{IH}$  of this pin during JTAG testing remains at 2.0 V. To attain this 3.6-V  $V_{IH}$  during programming, the ByteBlaster and ByteBlasterMV download cables must have a 5.0-V  $V_{CC}$ .
- (8) This parameter is measured with 50% of the outputs each sinking 12 mA. The  $I_{OH}$  parameter refers to high-level TTL or CMOS output current; the  $I_{OL}$  parameter refers to the low-level TTL or CMOS output current.
- (9) JTAG pin input leakage is typically  $-60$   $\mu\text{A}$ .
- (10) Capacitance is sample-tested only and is measured at  $25^\circ\text{C}$ .
- (11) Measured with a 16-bit loadable, enabled, up/down counter programmed into each LAB.  $I_{CC}$  is measured at  $0^\circ\text{C}$ .

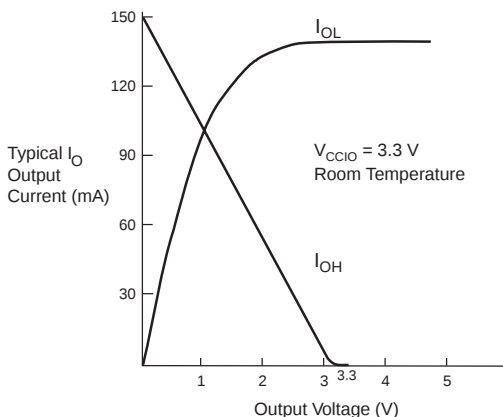
Figure 13 shows typical output drive characteristics for MAX 9000 devices with 5.0-V and 3.3-V  $V_{CCIO}$ .

**Figure 13. Output Drive Characteristics of MAX 9000 Devices***Note (1)*

5.0-V



3.3-V

**Note:**

- (1) Output drive characteristics include the JTAG TDO pin.

## Timing Model

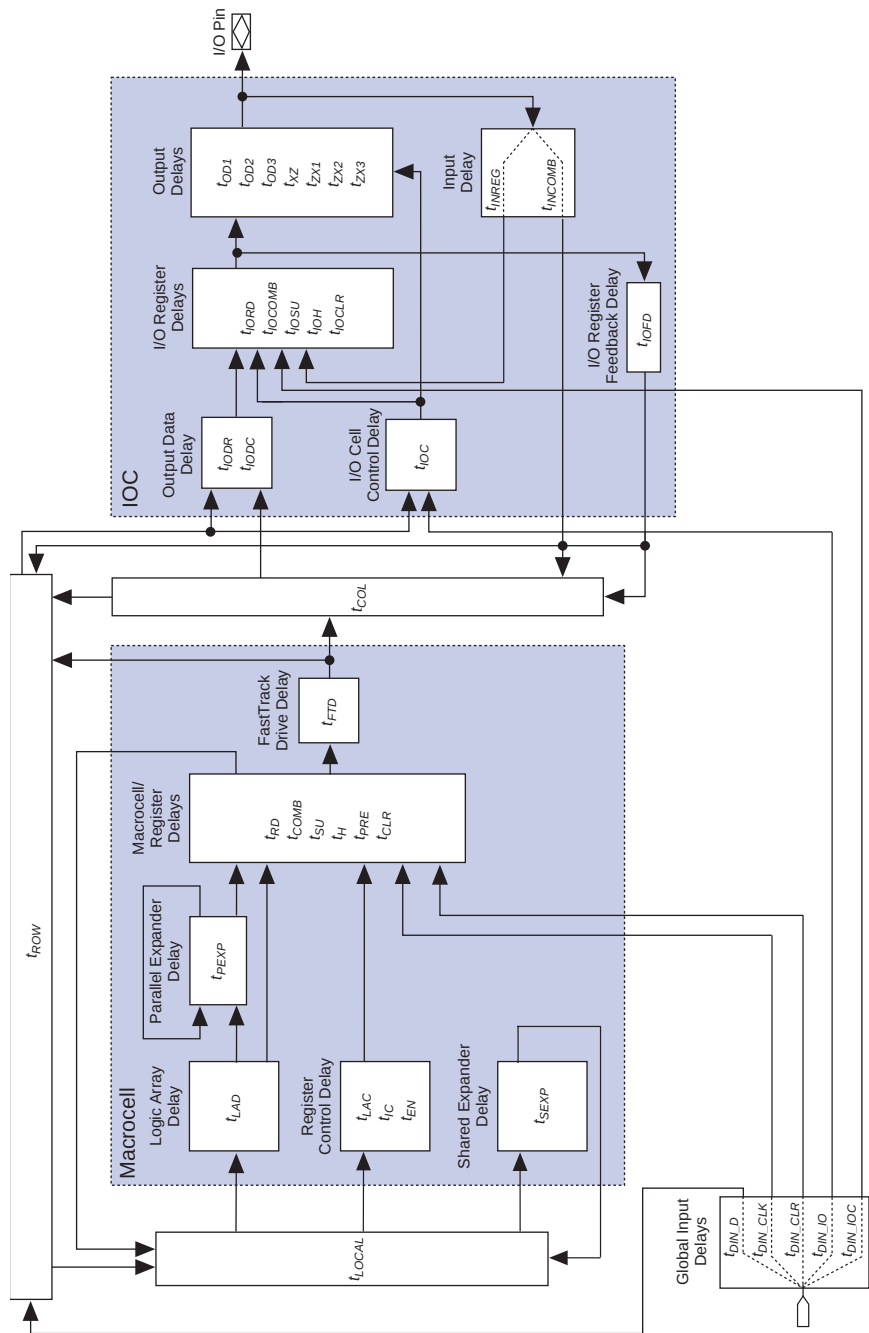
The continuous, high-performance FastTrack Interconnect ensures predictable performance and accurate simulation and timing analysis. This predictable performance contrasts with that of FPGAs, which use a segmented connection scheme and hence have unpredictable performance. Timing simulation and delay prediction are available with the MAX+PLUS II Simulator and Timing Analyzer, or with industry-standard EDA tools. The Simulator offers both pre-synthesis functional simulation to evaluate logic design accuracy and post-synthesis timing simulation with 0.1-ns resolution. The Timing Analyzer provides point-to-point timing delay information, setup and hold time prediction, and device-wide performance analysis.

The MAX 9000 timing model in [Figure 14](#) shows the delays that correspond to various paths and functions in the circuit. This model contains three distinct parts: the macrocell, IOC, and interconnect, including the row and column FastTrack Interconnect and LAB local array paths. Each parameter shown in [Figure 14](#) is expressed as a worst-case value in the internal timing characteristics tables in this data sheet. Hand-calculations that use the MAX 9000 timing model and these timing parameters can be used to estimate MAX 9000 device performance.



For more information on calculating MAX 9000 timing delays, see [Application Note 77 \(Understanding MAX 9000 Timing\)](#).

Figure 14. MAX 9000 Timing Model



Tables 18 through 21 show timing for MAX 9000 devices.

**Table 18. MAX 9000 External Timing Characteristics** *Note (1)*

| Symbol           | Parameter                                     | Conditions     |          | Speed Grade |      |         |      |         |      | Unit |
|------------------|-----------------------------------------------|----------------|----------|-------------|------|---------|------|---------|------|------|
|                  |                                               |                |          | -10         |      | -15     |      | -20     |      |      |
|                  |                                               |                |          | Min         | Max  | Min     | Max  | Min     | Max  |      |
| t <sub>PD1</sub> | Row I/O pin input to row I/O pin output       | C1 = 35 pF (2) |          |             | 10.0 |         | 15.0 |         | 20.0 | ns   |
| t <sub>PD2</sub> | Column I/O pin input to column I/O pin output | C1 = 35 pF (2) | EPM9320A |             | 10.8 |         |      |         |      | ns   |
|                  |                                               |                | EPM9320  |             |      |         | 16.0 |         | 23.0 | ns   |
|                  |                                               |                | EPM9400  |             |      |         | 16.2 |         | 23.2 | ns   |
|                  |                                               |                | EPM9480  |             |      |         | 16.4 |         | 23.4 | ns   |
|                  |                                               |                | EPM9560A |             | 11.4 |         |      |         |      | ns   |
|                  |                                               |                | EPM9560  |             |      |         | 16.6 |         | 23.6 | ns   |
| t <sub>FSU</sub> | Global clock setup time for I/O cell          |                |          | 3.0         |      | 5.0     |      | 6.0     |      | ns   |
| t <sub>FH</sub>  | Global clock hold time for I/O cell           |                |          | 0.0         |      | 0.0     |      | 0.0     |      | ns   |
| t <sub>FCO</sub> | Global clock to I/O cell output delay         | C1 = 35 pF     |          | 1.0 (3)     | 4.8  | 1.0 (3) | 7.0  | 1.0 (3) | 8.5  | ns   |
| t <sub>CNT</sub> | Minimum internal global clock period          | (4)            |          |             | 6.9  |         | 8.5  |         | 10.0 | ns   |
| f <sub>CNT</sub> | Maximum internal global clock frequency       | (4)            |          | 144.9       |      | 117.6   |      | 100.0   |      | MHz  |

**Table 19. MAX 9000 Internal Timing Characteristics** *Note (1)*

| Symbol     | Parameter                 | Conditions | Speed Grade |      |     |      |     |      | Unit |
|------------|---------------------------|------------|-------------|------|-----|------|-----|------|------|
|            |                           |            | -10         |      | -15 |      | -20 |      |      |
|            |                           |            | Min         | Max  | Min | Max  | Min | Max  |      |
| $t_{LAD}$  | Logic array delay         |            |             | 3.5  |     | 4.0  |     | 4.5  | ns   |
| $t_{LAC}$  | Logic control array delay |            |             | 3.5  |     | 4.0  |     | 4.5  | ns   |
| $t_{IC}$   | Array clock delay         |            |             | 3.5  |     | 4.0  |     | 4.5  | ns   |
| $t_{EN}$   | Register enable time      |            |             | 3.5  |     | 4.0  |     | 4.5  | ns   |
| $t_{SEXP}$ | Shared expander delay     |            |             | 3.5  |     | 5.0  |     | 7.5  | ns   |
| $t_{PEXP}$ | Parallel expander delay   |            |             | 0.5  |     | 1.0  |     | 2.0  | ns   |
| $t_{RD}$   | Register delay            |            |             | 0.5  |     | 1.0  |     | 1.0  | ns   |
| $t_{COMB}$ | Combinatorial delay       |            |             | 0.4  |     | 1.0  |     | 1.0  | ns   |
| $t_{SU}$   | Register setup time       |            | 2.4         |      | 3.0 |      | 4.0 |      | ns   |
| $t_H$      | Register hold time        |            | 2.0         |      | 3.5 |      | 4.5 |      | ns   |
| $t_{PRE}$  | Register preset time      |            |             | 3.5  |     | 4.0  |     | 4.5  | ns   |
| $t_{CLR}$  | Register clear time       |            |             | 3.7  |     | 4.0  |     | 4.5  | ns   |
| $t_{FTD}$  | FastTrack drive delay     |            |             | 0.5  |     | 1.0  |     | 2.0  | ns   |
| $t_{LPA}$  | Low-power adder           | (5)        |             | 10.0 |     | 15.0 |     | 20.0 | ns   |

**Table 20. IOC Delays**

| Symbol       | Parameter                                                                                     | Conditions | Speed Grade |     |     |      |     |      | Unit |
|--------------|-----------------------------------------------------------------------------------------------|------------|-------------|-----|-----|------|-----|------|------|
|              |                                                                                               |            | -10         |     | -15 |      | -20 |      |      |
|              |                                                                                               |            | Min         | Max | Min | Max  | Min | Max  |      |
| $t_{IODR}$   | I/O row output data delay                                                                     |            |             | 0.2 |     | 0.2  |     | 1.5  | ns   |
| $t_{IODC}$   | I/O column output data delay                                                                  |            |             | 0.4 |     | 0.2  |     | 1.5  | ns   |
| $t_{IOC}$    | I/O control delay                                                                             | (6)        |             | 0.5 |     | 1.0  |     | 2.0  | ns   |
| $t_{IORD}$   | I/O register clock-to-output delay                                                            |            |             | 0.6 |     | 1.0  |     | 1.5  | ns   |
| $t_{IOCOMB}$ | I/O combinatorial delay                                                                       |            |             | 0.2 |     | 1.0  |     | 1.5  | ns   |
| $t_{IOSU}$   | I/O register setup time before clock                                                          |            | 2.0         |     | 4.0 |      | 5.0 |      | ns   |
| $t_{IOH}$    | I/O register hold time after clock                                                            |            | 1.0         |     | 1.0 |      | 1.0 |      | ns   |
| $t_{IOCLR}$  | I/O register clear delay                                                                      |            |             | 1.5 |     | 3.0  |     | 3.0  | ns   |
| $t_{IOFD}$   | I/O register feedback delay                                                                   |            |             | 0.0 |     | 0.0  |     | 0.5  | ns   |
| $t_{INREG}$  | I/O input pad and buffer to I/O register delay                                                |            |             | 3.5 |     | 4.5  |     | 5.5  | ns   |
| $t_{INCOMB}$ | I/O input pad and buffer to row and column delay                                              |            |             | 1.5 |     | 2.0  |     | 2.5  | ns   |
| $t_{OD1}$    | Output buffer and pad delay, Slow slew rate = off, $V_{CCIO} = 5.0\text{ V}$                  | C1 = 35 pF |             | 1.8 |     | 2.5  |     | 2.5  | ns   |
| $t_{OD2}$    | Output buffer and pad delay, Slow slew rate = off, $V_{CCIO} = 3.3\text{ V}$                  | C1 = 35 pF |             | 2.3 |     | 3.5  |     | 3.5  | ns   |
| $t_{OD3}$    | Output buffer and pad delay, Slow slew rate = on, $V_{CCIO} = 5.0\text{ V}$ or $3.3\text{ V}$ | C1 = 35 pF |             | 8.3 |     | 10.0 |     | 10.5 | ns   |
| $t_{XZ}$     | Output buffer disable delay                                                                   | C1 = 5 pF  |             | 2.5 |     | 2.5  |     | 2.5  | ns   |
| $t_{ZX1}$    | Output buffer enable delay, Slow slew rate = off, $V_{CCIO} = 5.0\text{ V}$                   | C1 = 35 pF |             | 2.5 |     | 2.5  |     | 2.5  | ns   |
| $t_{ZX2}$    | Output buffer enable delay, Slow slew rate = off, $V_{CCIO} = 3.3\text{ V}$                   | C1 = 35 pF |             | 3.0 |     | 3.5  |     | 3.5  | ns   |
| $t_{ZX3}$    | Output buffer enable delay, Slow slew rate = on, $V_{CCIO} = 3.3\text{ V}$ or $5.0\text{ V}$  | C1 = 35 pF |             | 9.0 |     | 10.0 |     | 10.5 | ns   |

**Table 21. Interconnect Delays**

| Symbol         | Parameter                                  | Conditions | Speed Grade |     |     |     |     |     | Unit |
|----------------|--------------------------------------------|------------|-------------|-----|-----|-----|-----|-----|------|
|                |                                            |            | -10         |     | -15 |     | -20 |     |      |
|                |                                            |            | Min         | Max | Min | Max | Min | Max |      |
| $t_{LOCAL}$    | LAB local array delay                      |            |             | 0.5 |     | 0.5 |     | 0.5 | ns   |
| $t_{ROW}$      | FastTrack row delay                        | (6)        |             | 0.9 |     | 1.4 |     | 2.0 | ns   |
| $t_{COL}$      | FastTrack column delay                     | (6)        |             | 0.9 |     | 1.7 |     | 3.0 | ns   |
| $t_{DIN\_D}$   | Dedicated input data delay                 |            |             | 4.0 |     | 4.5 |     | 5.0 | ns   |
| $t_{DIN\_CLK}$ | Dedicated input clock delay                |            |             | 2.7 |     | 3.5 |     | 4.0 | ns   |
| $t_{DIN\_CLR}$ | Dedicated input clear delay                |            |             | 4.5 |     | 5.0 |     | 5.5 | ns   |
| $t_{DIN\_IOC}$ | Dedicated input I/O register clock delay   |            |             | 2.5 |     | 3.5 |     | 4.5 | ns   |
| $t_{DIN\_IO}$  | Dedicated input I/O register control delay |            |             | 5.5 |     | 6.0 |     | 6.5 | ns   |

**Notes to tables:**

- (1) These values are specified under the MAX 9000 device recommended operating conditions, shown in [Table 12 on page 24](#).
- (2) See [Application Note 77 \(Understanding MAX 9000 Timing\)](#) for more information on test conditions for  $t_{PD1}$  and  $t_{PD2}$  delays.
- (3) This parameter is a guideline that is sample-tested only. It is based on extensive device characterization. This parameter applies for both global and array clocking as well as both macrocell and I/O cell registers.
- (4) Measured with a 16-bit loadable, enabled, up / down counter programmed in each LAB.
- (5) The  $t_{LPA}$  parameter must be added to the  $t_{LOCAL}$  parameter for macrocells running in low-power mode.
- (6) The  $t_{ROW}$ ,  $t_{COL}$ , and  $t_{IOC}$  delays are worst-case values for typical applications. Post-compilation timing simulation or timing analysis is required to determine actual worst-case performance.

## Power Consumption

The supply power (P) versus frequency ( $f_{MAX}$ ) for MAX 9000 devices can be calculated with the following equation:

$$P = P_{INT} + P_{IO} = I_{CCINT} \times V_{CC} + P_{IO}$$

The  $P_{IO}$  value, which depends on the device output load characteristics and switching frequency, can be calculated using the guidelines given in [Application Note 74 \(Evaluating Power for Altera Devices\)](#). The  $I_{CCINT}$  value depends on the switching frequency and the application logic.

The  $I_{CCINT}$  value is calculated with the following equation:

$$I_{CCINT} = (A \times MC_{TON}) + [B \times (MC_{DEV} - MC_{TON})] + (C \times MC_{USED} \times f_{MAX} \times \log_{LC})$$

The parameters in this equation are shown below:

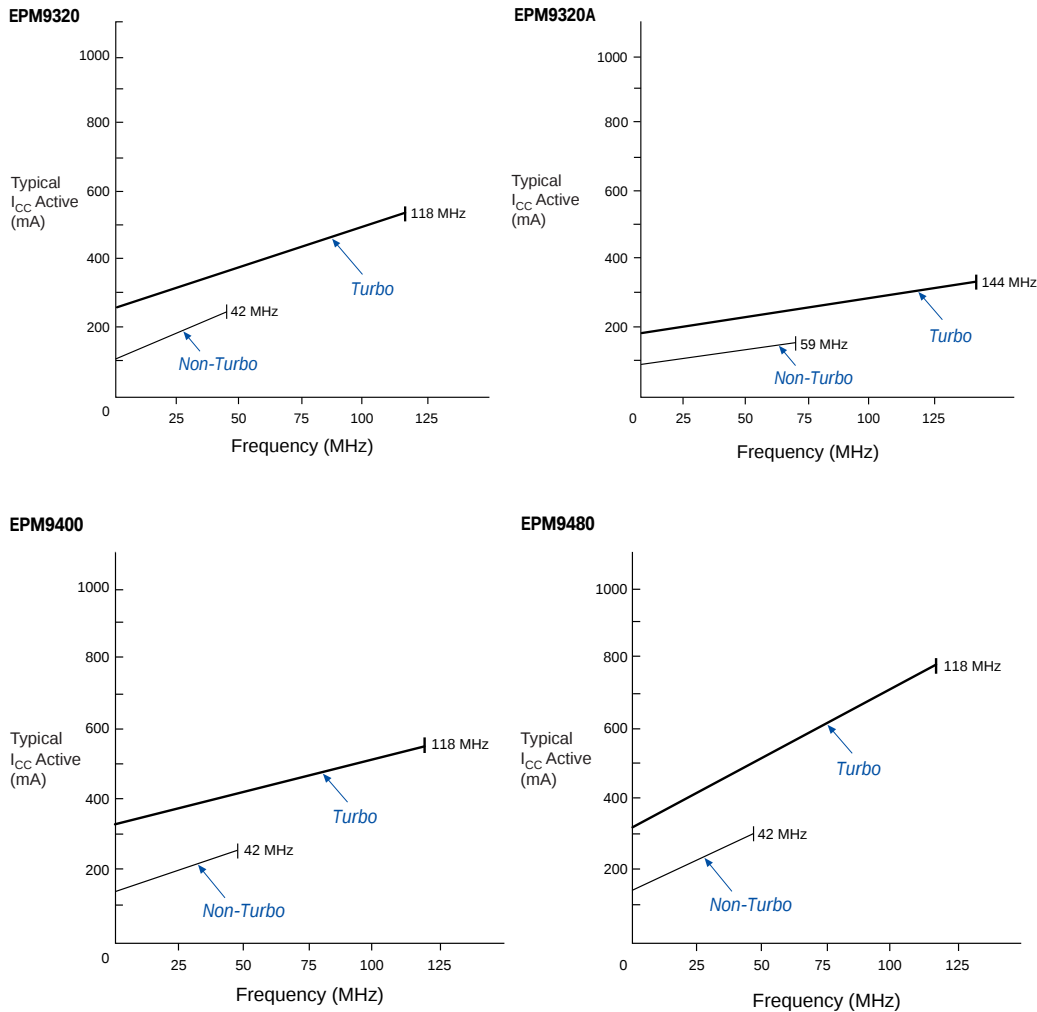
- $MC_{TON}$  = Number of macrocells with the Turbo Bit option turned on, as reported in the MAX+PLUS II Report File (.rpt)  
 $MC_{DEV}$  = Number of macrocells in the device  
 $MC_{USED}$  = Number of macrocells used in the design, as reported in the MAX+PLUS II Report File  
 $f_{MAX}$  = Highest clock frequency to the device  
 $tog_{LC}$  = Average percentage of logic cells toggling at each clock (typically 12.5%)  
A, B, C = Constants, shown in Table 22

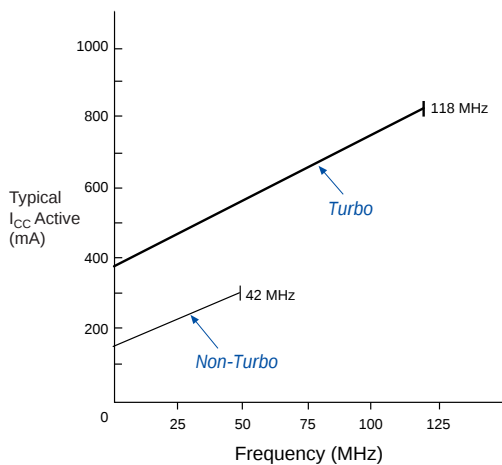
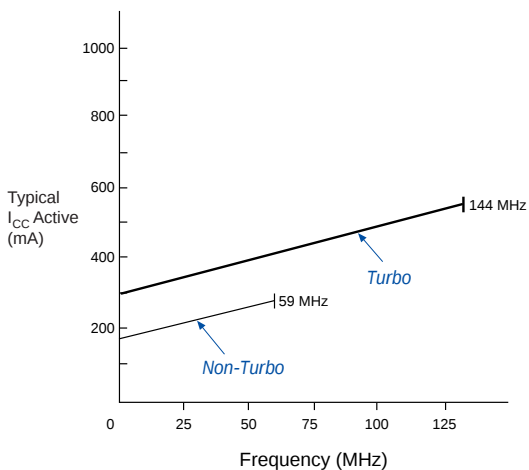
**Table 22. MAX 9000  $I_{CC}$  Equation Constants**

| Device   | Constant A | Constant B | Constant C |
|----------|------------|------------|------------|
| EPM9320  | 0.81       | 0.33       | 0.056      |
| EPM9320A | 0.56       | 0.31       | 0.024      |
| EPM9400  | 0.60       | 0.33       | 0.053      |
| EPM9480  | 0.68       | 0.29       | 0.064      |
| EPM9560  | 0.68       | 0.26       | 0.052      |
| EPM9560A | 0.56       | 0.31       | 0.024      |

This calculation provides an  $I_{CC}$  estimate based on typical conditions with no output load, using a typical pattern of a 16-bit, loadable, enabled up / down counter in each LAB. Actual  $I_{CC}$  values should be verified during operation, because the measurement is sensitive to the actual pattern in the device and the environmental operating conditions. Figure 15 shows typical supply current versus frequency for MAX 9000 devices.

Figure 15.  $I_{CC}$  vs. Frequency for MAX 9000 Devices (Part 1 of 2)



**Figure 15.  $I_{CC}$  vs. Frequency for MAX 9000 Devices (Part 2 of 2)****EPM9560****EPM9560A**

## Device Pin-Outs

Tables 23 through 26 show the dedicated pin names and numbers for each EPM9320, EPM9320A, EPM9400, EPM9480, EPM9560, and EPM9560A device package.

**Table 23. EPM9320 & EPM9320A Dedicated Pin-Outs (Part 1 of 2)** *Note (1)*

| Pin Name     | 84-Pin PLCC (2) | 208-Pin RQFP | 280-Pin PGA (3) | 356-Pin BGA |
|--------------|-----------------|--------------|-----------------|-------------|
| DIN1 (GCLK1) | 1               | 182          | V10             | AD13        |
| DIN2 (GCLK2) | 84              | 183          | U10             | AF14        |
| DIN3 (GCLR)  | 13              | 153          | V17             | AD1         |
| DIN4 (GOE)   | 72              | 4            | W2              | AC24        |
| TCK          | 43              | 78           | A9              | A18         |
| TMS          | 55              | 49           | D6              | E23         |
| TDI          | 42              | 79           | C11             | A13         |
| TD0          | 30              | 108          | A18             | D3          |

**Table 23. EPM9320 & EPM9320A Dedicated Pin-Outs (Part 2 of 2)** *Note (1)*

| Pin Name                   | 84-Pin PLCC (2)               | 208-Pin RQFP                                                                                                                       | 280-Pin PGA (3)                                                                                                                                                                                                                | 356-Pin BGA                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|----------------------------|-------------------------------|------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| GND                        | 6, 18, 24, 25, 48, 61, 67, 70 | 14, 20, 24, 31, 35, 41, 42, 43, 44, 46, 47, 66, 85, 102, 110, 113, 114, 115, 116, 118, 121, 122, 132, 133, 143, 152, 170, 189, 206 | D4, D5, D16, E4, E5, E6, E15, E16, F5, F15, G5, G15, H5, H15, J5, J15, K5, K15, L5, L15, M5, M15, N5, N15, P4, P5, P15, P16, R4, R5, R15, R16, T4, T5, T16                                                                     | A9, A22, A25, A26, B25, B26, D2, E1, E26, F2, G1, G25, G26, H2, J1, J25, J26, K2, L26, M26, N1, N25, P26, R2, T1, U2, U26, V1, V25, W25, Y26, AA2, AB1, AB26, AC26, AE1, AF1, AF2, AF4, AF7, AF20                                                                                                                                                                                                                                                                                                                                                                       |
| VCCINT<br>(5.0 V only)     | 14, 21, 28, 57, 64, 71        | 10, 19, 30, 45, 112, 128, 139, 148                                                                                                 | D15, E8, E10, E12, E14, R7, R9, R11, R13, R14, T14                                                                                                                                                                             | D26, F1, H1, K26, N26, P1, U1, W26, AE26, AF25, AF26                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| VCCIO<br>(3.3 or 5.0 V)    | 15, 37, 60, 79                | 5, 25, 36, 55, 72, 91, 111, 127, 138, 159, 176, 195                                                                                | D14, E7, E9, E11, E13, R6, R8, R10, R12, T13, T15                                                                                                                                                                              | A1, A2, A21, B1, B10, B24, D1, H26, K1, M25, R1, V26, AA1, AC25, AF5, AF8, AF19                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| No Connect<br>(N.C.)       | 29                            | 6, 7, 8, 9, 11, 12, 13, 15, 16, 17, 18, 109, 140, 141, 142, 144, 145, 146, 147, 149, 150, 151                                      | B6, K19, L2, L4, L18, L19, M1, M2, M3, M4, M16, M17, M18, M19, N1, N2, N3, N4, N16, N17, N18, N19, P1, P2, P3, P17, P18, P19, R1, R2, R3, R17, R18, R19, T1, T2, T3, T17, T18, T19, U1, U2, U3, U17, U18, U19, V1, V2, V19, W1 | B4, B5, B6, B7, B8, B9, B11, B12, B13, B14, B15, B16, B18, B19, B20, B21, B22, B23, C4, C23, D4, D23, E4, E22, F4, F23, G4, H4, H23, J23, K4, L4, L23, N4, P4, P23, R3, R26, T2, T3, T4, T5, T22, T23, T24, T25, T26, U3, U4, U5, U22, U23, U24, U25, V2, V3, V4, V5, V22, V23, V24, W1, W2, W3, W4, W5, W22, W23, W24, Y1, Y2, Y3, Y4, Y5, Y22, Y23, Y24, Y25, AA3, AA4, AA5, AA22, AA23, AA24, AA25, AA26, AB2, AB3, AB4, AB5, AB23, AB24, AB25, AC1, AC2, AC23, AD4, AD23, AE4, AE5, AE6, AE7, AE9, AE11, AE12, AE14, AE15, AE16, AE18, AE19, AE20, AE21, AE22, AE23 |
| VPP (4)                    | 56                            | 48                                                                                                                                 | C4                                                                                                                                                                                                                             | E25                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
| Total User<br>I/O Pins (5) | 60                            | 132                                                                                                                                | 168                                                                                                                                                                                                                            | 168                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |

**Notes:**

- (1) All pins not listed are user I/O pins.
- (2) Perform a complete thermal analysis before committing a design to this device package. See [Application Note 74 \(Evaluating Power for Altera Devices\)](#).
- (3) EPM9320A devices are not offered in this package.
- (4) During in-system programming, each device's VPP pin must be connected to the 5.0-V power supply. During normal device operation, the VPP pin is pulled up internally and can be connected to the 5.0-V supply or left unconnected.
- (5) The user I/O pin count includes dedicated input pins and all I/O pins.

**Table 24. EPM9400 Dedicated Pin-Outs** *Note (1)*

| Pin Name                | 84-Pin PLCC (2)                       | 208-Pin RQFP                                                                                                                       | 240-Pin RQFP                                                                                                                                 |
|-------------------------|---------------------------------------|------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------|
| DIN1 (GCLK1)            | 2                                     | 182                                                                                                                                | 210                                                                                                                                          |
| DIN2 (GCLK2)            | 1                                     | 183                                                                                                                                | 211                                                                                                                                          |
| DIN3 (GCLR)             | 12                                    | 153                                                                                                                                | 187                                                                                                                                          |
| DIN4 (GOE)              | 74                                    | 4                                                                                                                                  | 234                                                                                                                                          |
| TCK                     | 43                                    | 78                                                                                                                                 | 91                                                                                                                                           |
| TMS                     | 54                                    | 49                                                                                                                                 | 68                                                                                                                                           |
| TDI                     | 42                                    | 79                                                                                                                                 | 92                                                                                                                                           |
| TDO                     | 31                                    | 108                                                                                                                                | 114                                                                                                                                          |
| GND                     | 6, 13, 20, 26, 27, 47, 60, 66, 69, 73 | 14, 20, 24, 31, 35, 41, 42, 43, 44, 46, 47, 66, 85, 102, 110, 113, 114, 115, 116, 118, 121, 122, 132, 133, 143, 152, 170, 189, 206 | 5, 14, 25, 34, 45, 54, 65, 66, 81, 96, 110, 115, 126, 127, 146, 147, 166, 167, 186, 200, 216, 229                                            |
| VCCINT (5.0 V only)     | 16, 23, 30, 56, 63, 70                | 10, 19, 30, 45, 112, 128, 139, 148                                                                                                 | 4, 24, 44, 64, 117, 137, 157, 177                                                                                                            |
| VCCIO (3.3 or 5.0 V)    | 17, 37, 59, 80                        | 5, 25, 36, 55, 72, 91, 111, 127, 138, 159, 176, 195                                                                                | 15, 35, 55, 73, 86, 101, 116, 136, 156, 176, 192, 205, 220, 235                                                                              |
| No Connect (N.C.)       | —                                     | 6, 7, 8, 9, 11, 12, 13, 109, 144, 145, 146, 147, 149, 150, 151                                                                     | 1, 2, 3, 6, 7, 8, 9, 10, 11, 12, 13, 168, 169, 170, 171, 172, 173, 174, 175, 178, 179, 180, 181, 182, 183, 184, 185, 236, 237, 238, 239, 240 |
| VPP (3)                 | 55                                    | 48                                                                                                                                 | 67                                                                                                                                           |
| Total User I/O Pins (4) | 59                                    | 139                                                                                                                                | 159                                                                                                                                          |

**Notes:**

- (1) All pins not listed are user I/O pins.
- (2) Perform a complete thermal analysis before committing a design to this device package. See [Application Note 74 \(Evaluating Power for Altera Devices\)](#) for more information.
- (3) During in-system programming, each device's VPP pin must be connected to the 5.0-V power supply. During normal device operation, the VPP pin is pulled up internally and can be connected to the 5.0-V supply or left unconnected.
- (4) The user I/O pin count includes dedicated input pins and all I/O pins.

**Table 25. EPM9480 Dedicated Pin-Outs** *Note (1)*

| Pin Name                | 208-Pin RQFP                                                                                                                       | 240-Pin RQFP                                                                                      |
|-------------------------|------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------|
| DIN1 (GCLK1)            | 182                                                                                                                                | 210                                                                                               |
| DIN2 (GCLK2)            | 183                                                                                                                                | 211                                                                                               |
| DIN3 (GCLR)             | 153                                                                                                                                | 187                                                                                               |
| DIN4 (GOE)              | 4                                                                                                                                  | 234                                                                                               |
| TCK                     | 78                                                                                                                                 | 91                                                                                                |
| TMS                     | 49                                                                                                                                 | 68                                                                                                |
| TDI                     | 79                                                                                                                                 | 92                                                                                                |
| TDO                     | 108                                                                                                                                | 114                                                                                               |
| GND                     | 14, 20, 24, 31, 35, 41, 42, 43, 44, 46, 47, 66, 85, 102, 110, 113, 114, 115, 116, 118, 121, 122, 132, 133, 143, 152, 170, 189, 206 | 5, 14, 25, 34, 45, 54, 65, 66, 81, 96, 110, 115, 126, 127, 146, 147, 166, 167, 186, 200, 216, 229 |
| VCCINT (5.0 V only)     | 10, 19, 30, 45, 112, 128, 139, 148                                                                                                 | 4, 24, 44, 64, 117, 137, 157, 177                                                                 |
| VCCIO (3.3 or 5.0 V)    | 5, 25, 36, 55, 72, 91, 111, 127, 138, 159, 176, 195                                                                                | 15, 35, 55, 73, 86, 101, 116, 136, 156, 176, 192, 205, 220, 235                                   |
| No Connect (N.C.)       | 6, 7, 8, 9, 109, 149, 150, 151                                                                                                     | 1, 2, 3, 178, 179, 180, 181, 182, 183, 184, 185, 236, 237, 238, 239, 240                          |
| VPP (2)                 | 48                                                                                                                                 | 67                                                                                                |
| Total User I/O Pins (3) | 146                                                                                                                                | 175                                                                                               |

**Notes:**

- (1) All pins not listed are user I/O pins.
- (2) During in-system programming, each device's VPP pin must be connected to the 5.0-V power supply. During normal device operation, the VPP pin is pulled up internally and can be connected to the 5.0-V supply or left unconnected.
- (3) The user I/O pin count includes dedicated input pins and all I/O pins.

**Table 26. EPM9560 & EPM9560A Dedicated Pin-Outs (Part 1 of 2)** *Note (1)*

| Pin Name             | 208-Pin RQFP                                                                                                                       | 240-Pin RQFP                                                                                      | 280-Pin PGA (2)                                                                                                                                            | 304-Pin RQFP (2)                                                                                     | 356-Pin BGA                                                                                                                                                                                       |
|----------------------|------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| DIN1 (GCLK1)         | 182                                                                                                                                | 210                                                                                               | V10                                                                                                                                                        | 266                                                                                                  | AD13                                                                                                                                                                                              |
| DIN2 (GCLK2)         | 183                                                                                                                                | 211                                                                                               | U10                                                                                                                                                        | 267                                                                                                  | AF14                                                                                                                                                                                              |
| DIN3 (GCLR)          | 153                                                                                                                                | 187                                                                                               | V17                                                                                                                                                        | 237                                                                                                  | AD1                                                                                                                                                                                               |
| DIN4 (GOE)           | 4                                                                                                                                  | 234                                                                                               | W2                                                                                                                                                         | 296                                                                                                  | AC24                                                                                                                                                                                              |
| TCK                  | 78                                                                                                                                 | 91                                                                                                | A9                                                                                                                                                         | 114                                                                                                  | A18                                                                                                                                                                                               |
| TMS                  | 49                                                                                                                                 | 68                                                                                                | D6                                                                                                                                                         | 85                                                                                                   | E23                                                                                                                                                                                               |
| TDI                  | 79                                                                                                                                 | 92                                                                                                | C11                                                                                                                                                        | 115                                                                                                  | A13                                                                                                                                                                                               |
| TDO                  | 108                                                                                                                                | 114                                                                                               | A18                                                                                                                                                        | 144                                                                                                  | D3                                                                                                                                                                                                |
| GND                  | 14, 20, 24, 31, 35, 41, 42, 43, 44, 46, 47, 66, 85, 102, 110, 113, 114, 115, 116, 118, 121, 122, 132, 133, 143, 152, 170, 189, 206 | 5, 14, 25, 34, 45, 54, 65, 66, 81, 96, 110, 115, 126, 127, 146, 147, 166, 167, 186, 200, 216, 229 | D4, D5, D16, E4, E5, E6, E15, E16, F5, F15, G5, G15, H5, H15, J5, J15, K5, K15, L5, L15, M5, M15, N5, N15, P4, P5, P15, P16, R4, R5, R15, R16, T4, T5, T16 | 13, 22, 33, 42, 53, 62, 73, 74, 102, 121, 138, 155, 166, 167, 186, 187, 206, 207, 226, 254, 273, 290 | A9, A22, A25, A26, B25, B26, D2, E1, E26, F2, G1, G25, G26, H2, J1, J25, J26, K2, L26, M26, N1, N25, P26, R2, T1, U2, U26, V1, V25, W25, Y26, AA2, AB1, AB26, AC26, AE1, AF1, AF2, AF4, AF7, AF20 |
| VCCINT (5.0 V only)  | 10, 19, 30, 45, 112, 128, 139, 148                                                                                                 | 4, 24, 44, 64, 117, 137, 157, 177                                                                 | D15, E8, E10, E12, E14, R7, R9, R11, R13, R14, T14                                                                                                         | 12, 32, 52, 72, 157, 177, 197, 217                                                                   | D26, F1, H1, K26, N26, P1, U1, W26, AE26, AF25, AF26                                                                                                                                              |
| VCCIO (3.3 or 5.0 V) | 5, 25, 36, 55, 72, 91, 111, 127, 138, 159, 176, 195                                                                                | 15, 35, 55, 73, 86, 101, 116, 136, 156, 176, 192, 205, 220, 235                                   | D14, E7, E9, E11, E13, R6, R8, R10, R12, T13, T15                                                                                                          | 3, 23, 43, 63, 91, 108, 127, 156, 176, 196, 216, 243, 260, 279                                       | A1, A2, A21, B1, B10, B24, D1, H26, K1, M25, R1, V26, AA1, AC25, AF5, AF8, AF19                                                                                                                   |

| <b>Table 26. EPM9560 &amp; EPM9560A Dedicated Pin-Outs (Part 2 of 2)</b> <i>Note (1)</i> |                     |                     |                        |                                                                                                                                                                                      |                                                                                                                                                                                                                                                                                                                                    |
|------------------------------------------------------------------------------------------|---------------------|---------------------|------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>Pin Name</b>                                                                          | <b>208-Pin RQFP</b> | <b>240-Pin RQFP</b> | <b>280-Pin PGA (2)</b> | <b>304-Pin RQFP (2)</b>                                                                                                                                                              | <b>356-Pin BGA</b>                                                                                                                                                                                                                                                                                                                 |
| No Connect (N.C.)                                                                        | 109                 | —                   | B6, W1                 | 1, 2, 76, 77, 78, 79, 80, 81, 82, 83, 84, 145, 146, 147, 148, 149, 150, 151, 152, 153, 154, 227, 228, 229, 230, 231, 232, 233, 234, 235, 236, 297, 298, 299, 300, 301, 302, 303, 304 | B4, B5, B6, B7, B8, B9, B11, B12, B13, B14, B15, B16, B18, B19, B20, B21, B22, B23, C4, C23, D4, D23, E4, E22, F4, F23, G4, H4, H23, J23, K4, L4, L23, N4, P4, P23, T4, T23, U4, V4, V23, W4, Y4, AA4, AA23, AB4, AB23, AC23, AD4, AD23, AE4, AE5, AE6, AE7, AE9, AE11, AE12, AE14, AE15, AE16, AE18, AE19, AE20, AE21, AE22, AE23 |
| VPP (3)                                                                                  | 48                  | 67                  | C4                     | 75                                                                                                                                                                                   | E25                                                                                                                                                                                                                                                                                                                                |
| Total User I/O Pins (4)                                                                  | 153                 | 191                 | 216                    | 216                                                                                                                                                                                  | 216                                                                                                                                                                                                                                                                                                                                |

**Notes:**

- (1) All pins not listed are user I/O pins.
- (2) EPM9560A devices are not offered in this package.
- (3) During in-system programming, each device's VPP pin must be connected to the 5.0-V power supply. During normal device operation, the VPP pin is pulled up internally and can be connected to the 5.0-V supply or left unconnected.
- (4) The user I/O pin count includes dedicated input pins and all I/O pins.

## Revision History

Information contained in the *MAX 9000 Programmable Logic Device Family Data Sheet* version 6.4 supersedes information published in previous versions.

### Version 6.4

Version 6.4 of the *MAX 9000 Programmable Logic Device Family Data Sheet* contains the following change: Updated text on [page 19](#).

### Version 6.3

Version 6.3 of the *MAX 9000 Programmable Logic Device Family Data Sheet* contains the following change: added [Note \(7\)](#) to [Table 13](#).



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